

## LP295x-N Series of Adjustable Micropower Voltage Regulators

### 1 Features

- Input Voltage Range: 2.3 V to 30 V
- 5-V, 3-V, and 3.3-V Output Voltage Versions Available
- High Accuracy Output Voltage
- Ensured 100-mA Output Current
- Extremely Low Quiescent Current
- Low Dropout Voltage
- Extremely Tight Load and Line Regulation
- Very Low Temperature Coefficient
- Use as Regulator or Reference
- Needs Minimum Capacitance for Stability
- Current and Thermal Limiting
- Stable With Low-ESR Output Capacitors (10 mΩ to 6 Ω)
- LP2951-N Versions Only:
  - Error Flag Warns of Output Dropout
  - Logic-Controlled Electronic Shutdown
  - Output Programmable From 1.24 V to 29 V

### 2 Applications

- High-Efficiency Linear Regulator
- Regulator with Undervoltage Shutdown
- Low dropout Battery-powered Regulator
- Snap-ON/Snap-OFF Regulator

### 3 Description

The LP2950-N and LP2951-N are micropower voltage regulators with very low quiescent current (75  $\mu$ A typical) and very low dropout voltage (typical 40 mV at light loads and 380 mV at 100 mA). They are ideally suited for use in battery-powered systems. Furthermore, the quiescent current of the LP2950-N/LP2951-N increases only slightly in dropout, prolonging battery life.

Careful design of the LP2950-N/LP2951-N has minimized all contributions to the error budget. This includes a tight initial tolerance (0.5% typ.), extremely good load and line regulation (.05% typ.) and a very low output voltage temperature coefficient, making the part useful as a low-power voltage reference.

One such feature is an error flag output which warns of a low output voltage, often due to falling batteries on the input. It may be used for a power-on reset. A second feature is the logic-compatible shutdown input which enables the regulator to be switched on and off. Also, the part may be pin-strapped for a 5-V, 3-V, or 3.3-V output (depending on the version), or programmed from 1.24 V to 29 V with an external pair of resistors.

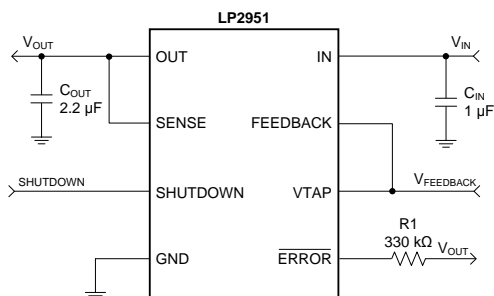
The LP2950-N is available in the surface-mount TO-252 package and in the popular 3-pin TO-92 package for pin-compatibility with older 5-V regulators. The 8-lead LP2951-N is available in plastic, ceramic dual-in-line, WSON, or metal can packages and offers additional system functions.

#### Device Information<sup>(1)</sup>

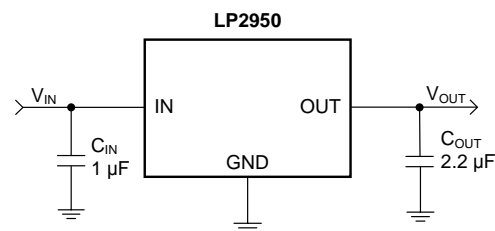
PART NUMBER	PACKAGE	BODY SIZE (NOM)
LP2950-N	TO-92 (3)	4.30 mm x 4.30 mm
	TO-252 (3)	9.91 mm x 6.58 mm
LP2951-N	SOIC (8)	4.90 mm x 3.91 mm
	VSSOP (8)	3.00 mm x 3.00 mm
	WSON (8)	4.00 mm x 4.00 mm
	PDIP (8)	9.81 mm x 6.35 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

#### LP2951 Simplified Schematic



#### LP2950-N Simplified Schematic



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

<b>Changes from Revision N (May 2013) to Revision O</b>	<b>Page</b>
<ul style="list-style-type: none"> <li>Added <i>Device Information</i> and <i>ESD Rating</i> tables, <i>Feature Description</i>, <i>Device Functional Modes</i>, <i>Application and Implementation</i>, <i>Power Supply Recommendations</i>, <i>Layout</i>, <i>Device and Documentation Support</i>, and <i>Mechanical, Packaging, and Orderable Information</i> sections; moved some curves to <i>Application Curves</i> section; update pin names; change package nomenclature from National to TI .....</li> </ul>	<b>1</b>

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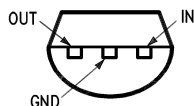
<b>Changes from Revision M (April 2013) to Revision N</b>	<b>Page</b>
<ul style="list-style-type: none"> <li>Changed layout of National Data Sheet to TI format .....</li> </ul>	<b>1</b>

## 5 Voltage Options

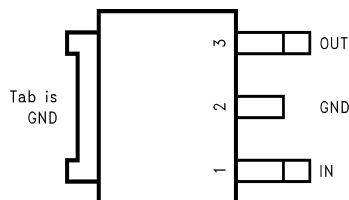
DEVICE NUMBER	PACKAGE	VOLTAGE OPTION (V)
LP2950-N	TO-92 (LP)	3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		3.3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		5 ( $\pm 0.5\%$ , $\pm 1\%$ )
	TO-252 (NDP)	3 ( $\pm 1\%$ )
		3.3 ( $\pm 1\%$ )
		5 ( $\pm 1\%$ )
LP2951-N	SOIC (D)	3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		3.3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		5 ( $\pm 0.5\%$ , $\pm 1\%$ )
	VSSOP (DGK)	3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		3.3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		5 ( $\pm 0.5\%$ , $\pm 1\%$ )
	WSOP (NGT)	3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		3.3 ( $\pm 0.5\%$ , $\pm 1\%$ )
		5 ( $\pm 0.5\%$ , $\pm 1\%$ )
	PDIP (P)	5 ( $\pm 0.5\%$ , $\pm 1\%$ )

## 6 Pin Configuration and Functions

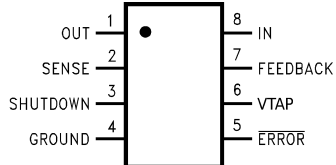
**TO-92 Package (LP)  
3 Pins  
Bottom View**



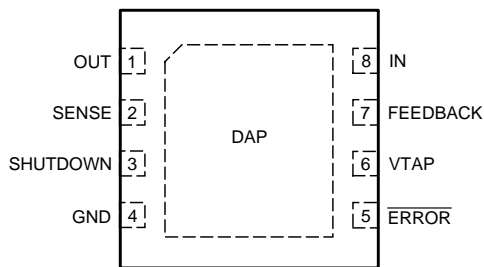
**TO-252 Package (NDP)  
3 Pins  
Front View**



**PDIP, SOIC, VSSOP Packages (P, D, DGK)  
8 Pins  
Top View**



**WSOP Package (NGT)  
8 Pins  
Top View**



Connect DAP to GND at device pin 4.

**Pin Functions: LP2950-N**

NAME	PIN		I/O	DESCRIPTION
	LP2950			
	LP	NDP		
GND	2	2	-	Ground
INPUT	3	1	I	Input supply voltage
OUTPUT	1	3	O	Regulated output voltage

**Pin Functions: LP2951-N**

NAME	PIN		I/O	DESCRIPTION
	LP2951			
	D, DGK, P	NGT		
ERROR	5	5	O	Error output.
FEEDBACK	7	7	I	Voltage feedback input
GROUND	4	4	-	Ground
INPUT	8	8	I	Input supply voltage
OUTPUT	1	1	O	Regulated output voltage
SENSE	2	2	I	Output voltage sense
SHUTDOWN	3	3	I	Disable device
VTAP	6	6	O	Internal resistor divider

## 7 Specifications

### 7.1 Absolute Maximum Ratings

 over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

	MIN	MAX	UNIT
Input supply voltage - SHUTDOWN input voltage error comparator output voltage <sup>(3)</sup>	-0.3	30	V
FEEDBACK input voltage <sup>(3)(4)</sup>	-1.5	30	V
Power dissipation	Internally Limited		
Junction temperature (T <sub>J</sub> )	150		°C
Soldering dwell time, temperature	Wave	4 seconds, 260	
	Infrared	10 seconds, 240	
	Vapor phase	75 seconds, 219	
Storage temperature range, T <sub>stg</sub>	-65	150	

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) May exceed input supply voltage.
- (4) When used in dual-supply systems where the output terminal sees loads returned to a negative supply, the output voltage should be diode-clamped to ground.

### 7.2 ESD Ratings

	VALUE	UNIT
V <sub>(ESD)</sub> Electrostatic discharge Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±2500	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
Maximum input supply voltage			30	V
Junction temperature (T <sub>J</sub> ) <sup>(2)</sup>	LP2950AC-XX, LP2950C-XX	-40	125	°C
	LP2951	-55	150	°C
	LP2951AC-XX, LP2951C-XX	-40	125	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The junction-to-ambient thermal resistances are as follows: 157.4°C/W for the TO-92(LP) package, 51.3°C/W for the TO-252 (NDP) package, 56.3°C/W for the molded PDIP (P), 117.7°C/W for the molded plastic SOIC (D), 171°C/W for the molded plastic VSSOP (DGK). The above thermal resistances for the P, D, and DGK packages apply when the package is soldered directly to the PCB. The value of R<sup>θJA</sup> for the WSON (NGT) package is typically 43.3°C/W but is dependent on the PCB trace area, trace material, and the number of layers and thermal vias. For details of thermal resistance and power dissipation for the WSON package, refer to Texas Instruments Application Note AN-1187 *Leadless Leadframe Package (LLP)* (SNOA401).

### 7.4 Thermal Information: LP2950-N

THERMAL METRIC <sup>(1)</sup>		LP2950-N		UNIT
		LP	NDP	
		3 PINS		
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	157.4	51.3	°C/W
R <sub>θJC(top)</sub>	Junction-to-case (top) thermal resistance	81.2	53.5	
R <sub>θJB</sub>	Junction-to-board thermal resistance	153.6	30.4	
ψ <sub>JT</sub>	Junction-to-top characterization parameter	25.2	5.5	
ψ <sub>JB</sub>	Junction-to-board characterization parameter	n/a	30	
R <sub>θJC(bot)</sub>	Junction-to-case (bottom) thermal resistance	n/a	2.2	

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

### 7.5 Thermal Information: LP2951-N

THERMAL METRIC <sup>(1)</sup>		LP2951-N				UNIT
		P	D	DGK	NGT	
		8 PINS		8 PINS		
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	56.3	117.7	171.0	43.3	°C/W
R <sub>θJC(top)</sub>	Junction-to-case (top) thermal resistance	45.7	63.7	62.3	35.0	
R <sub>θJB</sub>	Junction-to-board thermal resistance	33.5	57.9	91.4	23.3	
ψ <sub>JT</sub>	Junction-to-top characterization parameter	22.9	15.9	8.9	0.5	
ψ <sub>JB</sub>	Junction-to-board characterization parameter	33.3	57.5	90.1	20.5	
R <sub>θJC(bot)</sub>	Junction-to-case (bottom) thermal resistance	n/a	n/a	n/a	9.1	

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 7.6 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

PARAMETER	TEST CONDITIONS <sup>(1)</sup>	LP2951 <sup>(2)</sup>			LP2950AC-XX LP2951AC-XX			LP2950C-XX LP2951C-XX			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
<b>3-V VERSIONS<sup>(3)</sup></b>											
Output voltage	T <sub>J</sub> = 25°C	2.985	3	3.015	2.985	3	3.015	2.970	3	3.030	V <sup>(4)</sup>
	-25°C ≤ T <sub>J</sub> ≤ 85°C				2.970	3	3.030	2.955	3	3.045	V <sup>(5)</sup>
	Full operating temperature range	2.964	3	3.036							V <sup>(4)</sup>
Output voltage	100 μA ≤ I <sub>L</sub> ≤ 100 mA, 100 μA ≤ I <sub>L</sub> ≤ 100 mA, T <sub>J</sub> ≤ T <sub>JMAX</sub>	2.955	3	3.045							V <sup>(4)</sup>
					2.958	3	3.042	2.928	3	3.072	V <sup>(5)</sup>
<b>3.3-V VERSIONS<sup>(3)</sup></b>											
Output voltage	T <sub>J</sub> = 25°C	3.284	3.3	3.317	3.284	3.3	3.317	3.267	3.3	3.333	V <sup>(4)</sup>
	-25°C ≤ T <sub>J</sub> ≤ 85°C		3.3		3.267	3.3	3.333	3.251	3.3	3.350	V <sup>(5)</sup>
	Full operating temperature range	3.260	3.3	3.340							V <sup>(4)</sup>
Output voltage	100 μA ≤ I <sub>L</sub> ≤ 100 mA, T <sub>J</sub> ≤ T <sub>JMAX</sub>	3.251	3.3	3.350							V <sup>(4)</sup>
					3.254	3.3	3.346	3.221	3.3	3.379	V <sup>(5)</sup>
<b>5-V VERSIONS<sup>(3)</sup></b>											
Output voltage	T <sub>J</sub> = 25°C	4.975	5	5.025	4.975	5	5.025	4.95	5	5.05	V <sup>(4)</sup>
	-25°C ≤ T <sub>J</sub> ≤ 85°C		5		4.95	5	5.05	4.925	5	5.075	V <sup>(5)</sup>
	Full operating temperature range	4.94	5	5.06							V <sup>(4)</sup>
Output voltage	100 μA ≤ I <sub>L</sub> ≤ 100 mA, T <sub>J</sub> ≤ T <sub>JMAX</sub>	4.925	5	5.075							V <sup>(4)</sup>
					4.925	5	5.075	4.88	5	5.12	V <sup>(5)</sup>
<b>ALL VOLTAGE OPTIONS</b>											
Output voltage temperature coefficient	See <sup>(6)</sup> , -40°C ≤ T <sub>J</sub> ≤ 125°C	20	120								ppm/°C <sup>(4)</sup>
					20	100		50	150		ppm/°C <sup>(5)</sup>
Line regulation <sup>(7)</sup>	(V <sub>O</sub> NOM + 1)V ≤ V <sub>in</sub> ≤ 30 V <sup>(8)</sup>	0.03	0.1		0.03	0.11		0.04	0.2		% <sup>(4)</sup>
	(V <sub>O</sub> NOM + 1)V ≤ V <sub>in</sub> ≤ 30 V <sup>(8)</sup> , -40°C ≤ T <sub>J</sub> ≤ 125°C	0.03	0.5								% <sup>(4)</sup>
Load regulation <sup>(7)</sup>	100 μA ≤ I <sub>L</sub> ≤ 100 mA	0.04	0.1		0.04	0.1		0.1	0.2		% <sup>(4)</sup>
	100 μA ≤ I <sub>L</sub> ≤ 100 mA, -40°C ≤ T <sub>J</sub> ≤ 125°C	0.04	0.3					0.1	0.3		% <sup>(5)</sup>

- (1) Unless otherwise noted, all limits apply for T<sub>A</sub> = T<sub>J</sub> = 25°C as well as specified for V<sub>IN</sub> = (V<sub>ONOM</sub> + 1)V, I<sub>L</sub> = 100 μA and C<sub>L</sub> = 1 μF for 5-V versions and 2.2 μF for 3-V and 3.3-V versions. Additional conditions for the 8-pin versions are FEEDBACK tied to VTAP, OUTPUT tied to SENSE, and V<sub>SHUTDOWN</sub> ≤ 0.8 V.
- (2) A Military RETS specification is available on request.
- (3) All LP2950 devices have the nominal output voltage coded as the last two digits of the part number. In the LP2951 products, the 3-V and 3.3-V versions are designated by the last two digits, but the 5-V version is denoted with no code at this location of the part number (refer to [Mechanical, Packaging, and Orderable Information](#)).
- (4) Ensured and 100% production tested.
- (5) Ensured but not 100% production tested. These limits are not used to calculate outgoing AQL levels.
- (6) Output or reference voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
- (7) Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output voltage due to heating effects are covered under the specification for thermal regulation.
- (8) Line regulation for the LP2951-N is tested at 150°C for I<sub>L</sub> = 1 mA. For I<sub>L</sub> = 100 μA and T<sub>J</sub> = 125°C, line regulation is specified by design to 0.2%. See [Typical Characteristics](#) for line regulation versus temperature and load current.

**Electrical Characteristics (continued)**

 over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

PARAMETER	TEST CONDITIONS <sup>(1)</sup>	LP2951 <sup>(2)</sup>			LP2950AC-XX LP2951AC-XX			LP2950C-XX LP2951C-XX			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
Dropout voltage <sup>(9)</sup>	$I_L = 100 \mu\text{A}$		50	80		50	80		50	80	mV <sup>(4)</sup>
	$I_L = 100 \mu\text{A}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			150							mV <sup>(4)</sup>
							150			150	mV <sup>(5)</sup>
	$I_L = 100 \text{mA}$		380	450		380	450		380	450	mV <sup>(4)</sup>
$I_L = 100 \text{mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$				600			600			600	mV <sup>(4)</sup>
						600			600	mV <sup>(5)</sup>	
Ground current	$I_L = 100 \mu\text{A}$		75	120		75	120		75	120	$\mu\text{A}$ <sup>(4)</sup>
	$I_L = 100 \mu\text{A}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			140						140	$\mu\text{A}$ <sup>(4)</sup>
							140			140	$\mu\text{A}$ <sup>(5)</sup>
	$I_L = 100 \text{mA}$		8	12		8	12		8	12	$\text{mA}$ <sup>(4)</sup>
$I_L = 100 \text{mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$				14						14	$\text{mA}$ <sup>(4)</sup>
						14			14	$\text{mA}$ <sup>(5)</sup>	
Dropout ground current	$V_{in} = (V_{O\text{NOM}} - 0.5)\text{V}, I_L = 100 \mu\text{A}$		110	170		110	170		110	170	$\mu\text{A}$ <sup>(4)</sup>
	$V_{in} = (V_{O\text{NOM}} - 0.5)\text{V}, I_L = 100 \mu\text{A}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			200			200			200	$\mu\text{A}$ <sup>(4)</sup>
						200			200	$\mu\text{A}$ <sup>(5)</sup>	
Current limit	$V_{out} = 0$		160	200		160	200		160	200	$\text{mA}$ <sup>(4)</sup>
	$V_{out} = 0, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			220						220	$\text{mA}$ <sup>(4)</sup>
						220			220	$\text{mA}$ <sup>(5)</sup>	
Thermal Regulation	See <sup>(10)</sup>		0.05	0.2		0.05	0.2		0.05	0.2	%/W <sup>(4)</sup>
Output noise 10 Hz to 100 kHz	$C_L = 1 \mu\text{F}$ (5 V Only)		430			430			430		$\mu\text{V rms}$
	$C_L = 200 \mu\text{F}$		160			160			160		$\mu\text{V rms}$
	$C_L = 3.3 \mu\text{F}$ (Bypass = 0.01 $\mu\text{F}$ Pins 7 to 1 (LP2951-N))		100			100			100		$\mu\text{V rms}$
<b>8-PIN VERSIONS ONLY</b>		<b>LP2951</b>			<b>LP2951AC-XX</b>			<b>LP2951C-XX</b>			
Reference voltage		1.22	1.235	1.25	1.22	1.235	1.25	1.21	1.235	1.26	V <sup>(4)</sup>
	$-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		1.2	1.26							V <sup>(4)</sup>
Reference voltage	See <sup>(11)</sup> , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		1.19	1.27							V <sup>(4)</sup>
						1.19	1.27	1.185	1.285		V <sup>(5)</sup>
Feedback pin bias current			20	40		20	40		20	40	nA <sup>(4)</sup>
	$-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			60							nA <sup>(4)</sup>
							60			60	nA <sup>(5)</sup>
Reference voltage temperature coefficient	See <sup>(6)</sup>		20			20			50		ppm/°C
Feedback pin bias current temperature coefficient			0.1			0.1			0.1		nA/°C

(9) Dropout Voltage is defined as the input to output differential at which the output voltage drops 100 mV below its nominal value measured at 1-V differential. At very low values of programmed output voltage, the minimum input supply voltage of 2 V (2.3 V overtemperature) must be taken into account.

(10) Thermal regulation is defined as the change in output voltage at a time T after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 50 mA load pulse at  $V_{IN} = 30 \text{V}$  (1.25-W pulse) for  $T = 10 \text{ms}$ .

(11)  $V_{REF} \leq V_{OUT} \leq (V_{IN} - 1 \text{V}), 2.3 \text{V} \leq V_{IN} \leq 30 \text{V}, 100 \mu\text{A} \leq I_L \leq 100 \text{mA}, T_J \leq T_{J\text{MAX}}$ .

### Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

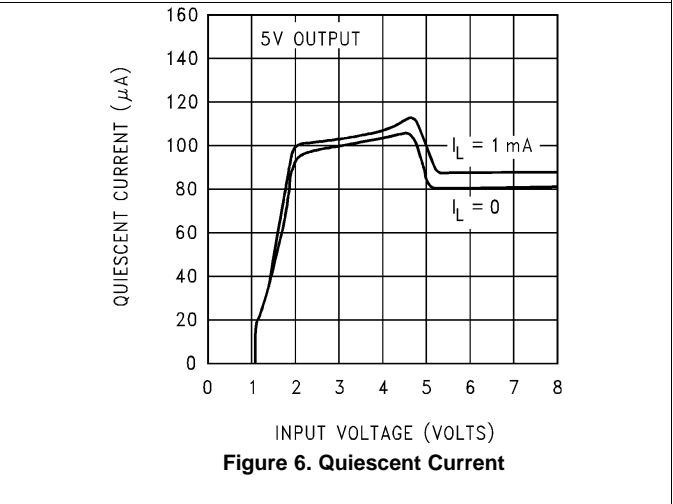
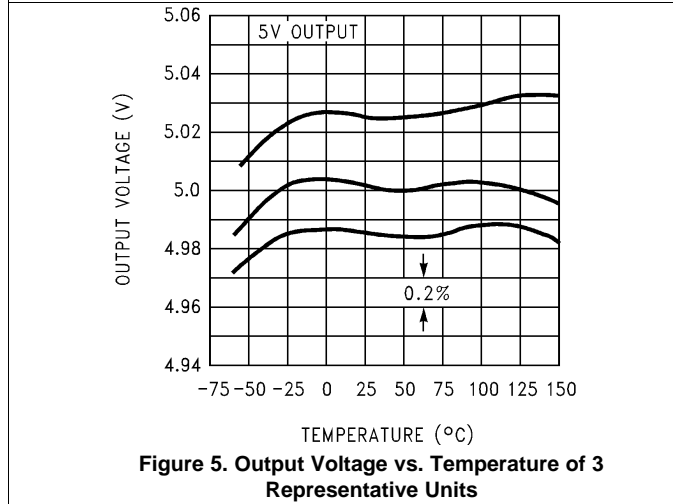
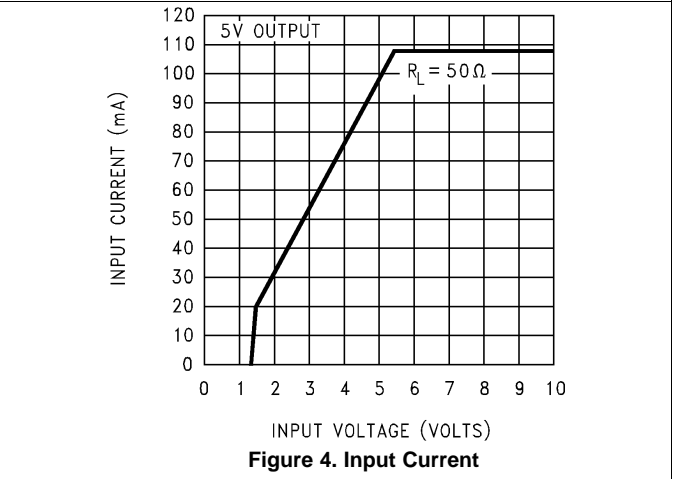
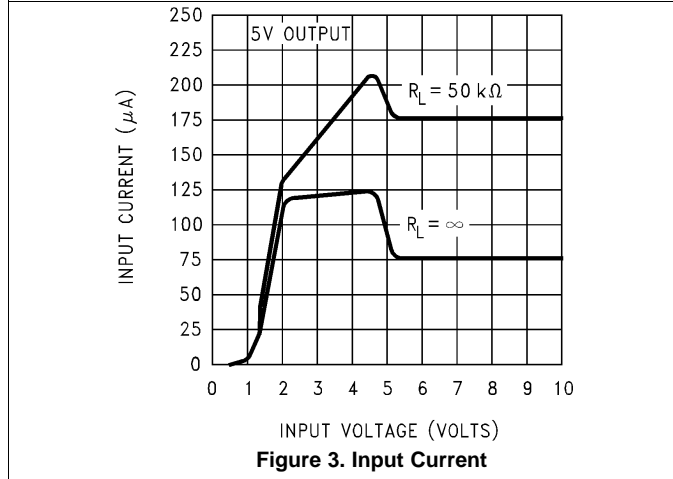
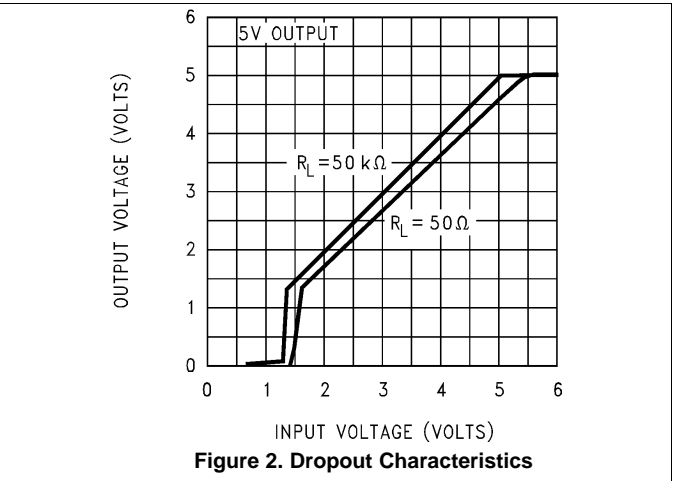
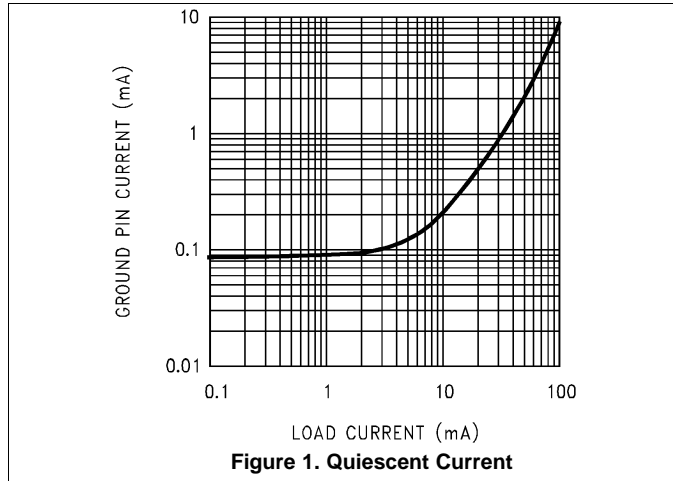
PARAMETER	TEST CONDITIONS <sup>(1)</sup>	LP2951 <sup>(2)</sup>			LP2950AC-XX LP2951AC-XX			LP2950C-XX LP2951C-XX			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
<b>ERROR COMPARATOR</b>											
Output leakage current	$V_{OH} = 30\text{ V}$		0.01	1		0.01	1		0.01	1	$\mu\text{A}^{(4)}$
	$V_{OH} = 30\text{ V}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			2							$\mu\text{A}^{(4)}$
							2			2	$\mu\text{A}^{(5)}$
Output low voltage	$V_{in} = (V_{ONOM} - 0.5)\text{V}, I_{OL} = 400\ \mu\text{A}$		150	250		150	250		150	250	$\text{mV}^{(4)}$
	$V_{in} = (V_{ONOM} - 0.5)\text{V}, I_{OL} = 400\ \mu\text{A}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			400		400			400		$\text{mV}^{(4)}$
							400			400	$\text{mV}^{(5)}$
Upper threshold voltage	See <sup>(12)</sup>		40	60		40	60		40	60	$\text{mV}^{(4)}$
	See <sup>(12)</sup> , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		25								$\text{mV}^{(4)}$
						25			25		$\text{mV}^{(5)}$
Lower threshold voltage	See <sup>(12)</sup>		75	95		75	95		75	95	$\text{mV}^{(4)}$
	See <sup>(12)</sup> , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			140							$\text{mV}^{(4)}$
							140			140	$\text{mV}^{(5)}$
Hysteresis	See <sup>(12)</sup>		15			15			15	$\text{mV}$	
<b>SHUTDOWN INPUT</b>											
Input			1.3			1.3			1.3		V
Logic voltage	Low (Regulator ON), $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			0.6							$\text{V}^{(4)}$
							0.7			0.7	$\text{V}^{(5)}$
Logic voltage	High (Regulator OFF), $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	2									$\text{V}^{(4)}$
					2			2			$\text{V}^{(5)}$
Shutdown pin input current	$V_{shutdown} = 2.4\text{ V}$		30	50		30	50		30	50	$\mu\text{A}^{(4)}$
	$V_{shutdown} = 2.4\text{ V}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			100							$\mu\text{A}^{(4)}$
							100			100	$\mu\text{A}^{(5)}$
	$V_{shutdown} = 30\text{ V}$		450	600		450	600		450	600	$\mu\text{A}^{(4)}$
	$V_{shutdown} = 30\text{ V}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$				750						750
						750			750	$\mu\text{A}^{(5)}$	
Regulator output current in shutdown	See <sup>(13)</sup>		3	10		3	10		3	10	$\mu\text{A}^{(4)}$
	$-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			20						20	$\mu\text{A}^{(4)}$
						20			20	$\mu\text{A}^{(5)}$	

(12) Comparator thresholds are expressed in terms of a voltage differential at the Feedback terminal below the nominal reference voltage measured at  $V_{in} = (V_{ONOM} + 1)\text{V}$ . To express these thresholds in terms of output voltage change, multiply by the error amplifier gain =  $V_{OUT}/V_{REF} = (R1 + R2)/R2$ . For example, at a programmed output voltage of 5 V, the Error output is specified to go low when the output drops by 95 mV  $\times 5\text{ V}/1.235\text{ V} = 384\text{ mV}$ . Thresholds remain constant as a percent of  $V_{out}$  as  $V_{out}$  is varied, with the dropout warning occurring at typically 5% below nominal, 7.5% ensured.

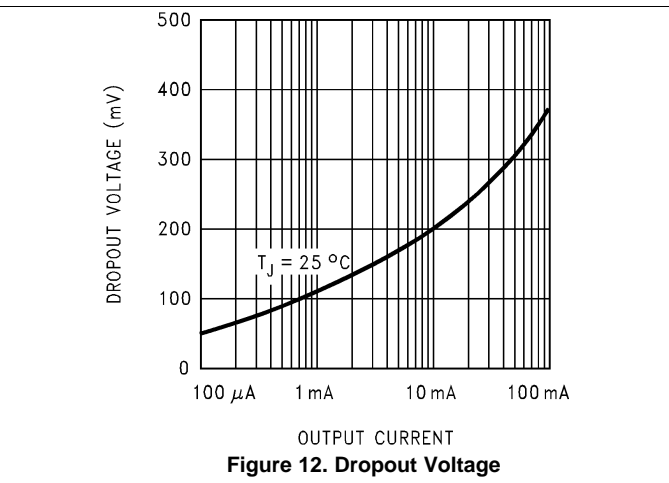
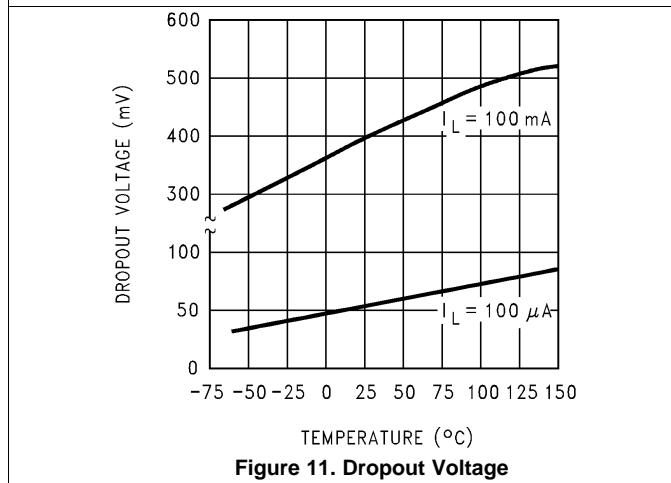
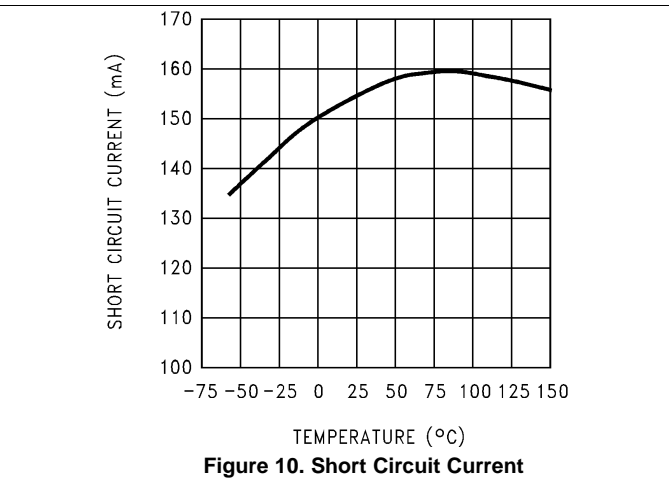
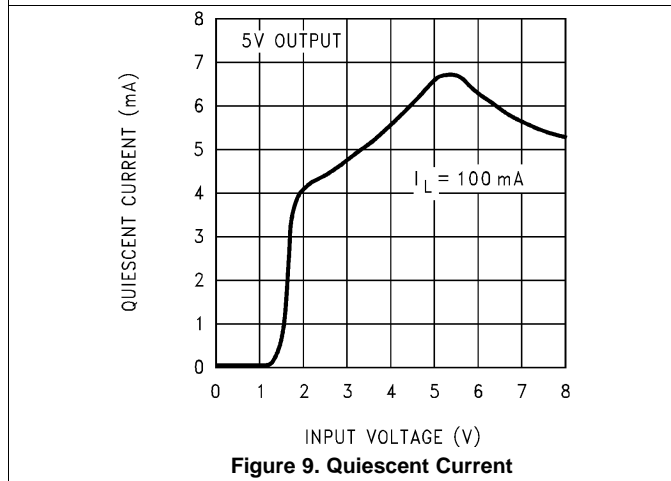
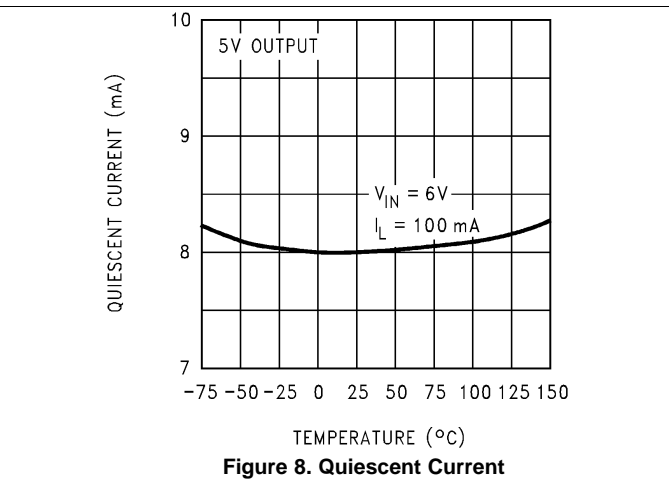
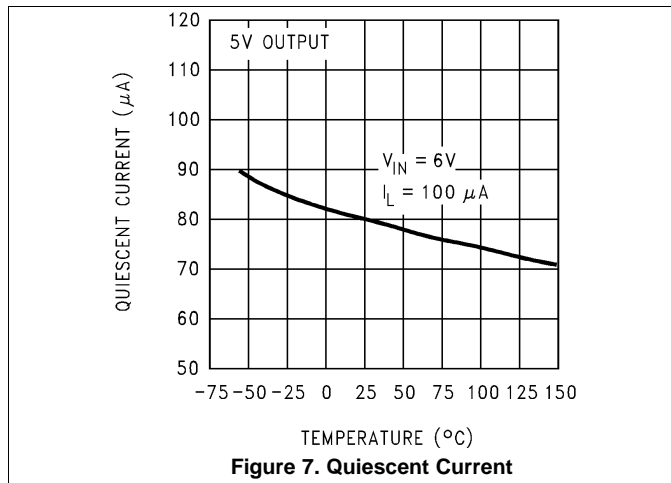
(13)  $V_{SHUTDOWN} \geq 2\text{ V}, V_{IN} \leq 30\text{ V}, V_{OUT} = 0$ , Feedback pin tied to  $V_{TAP}$ .



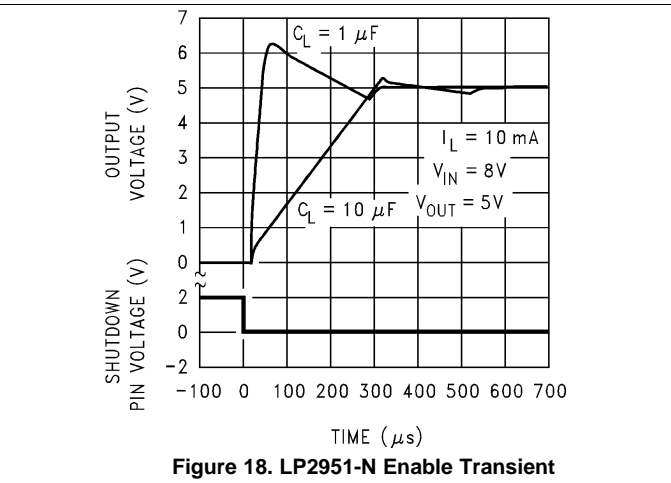
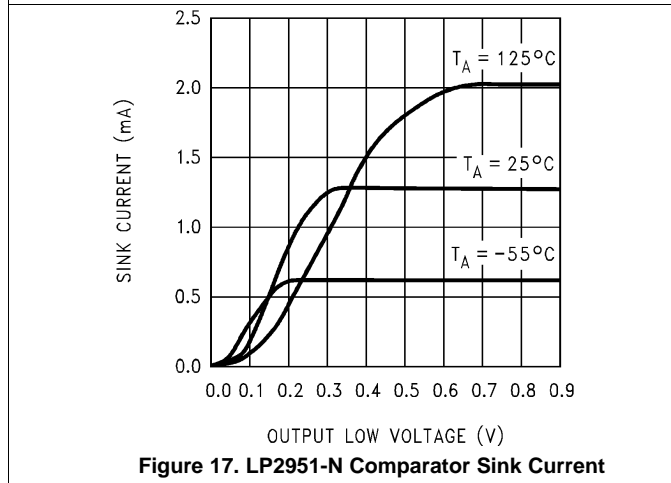
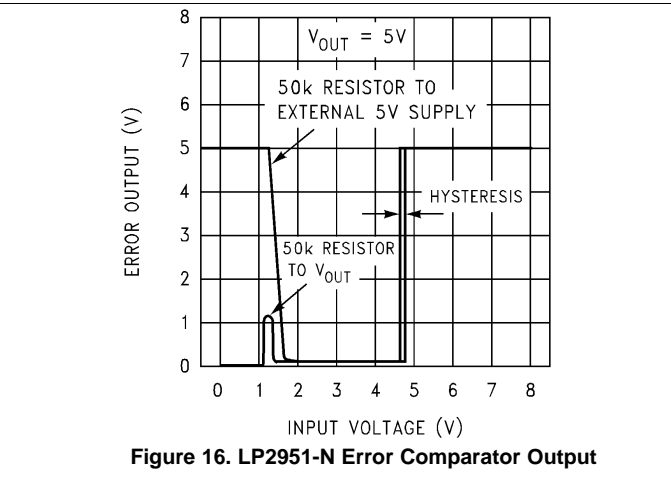
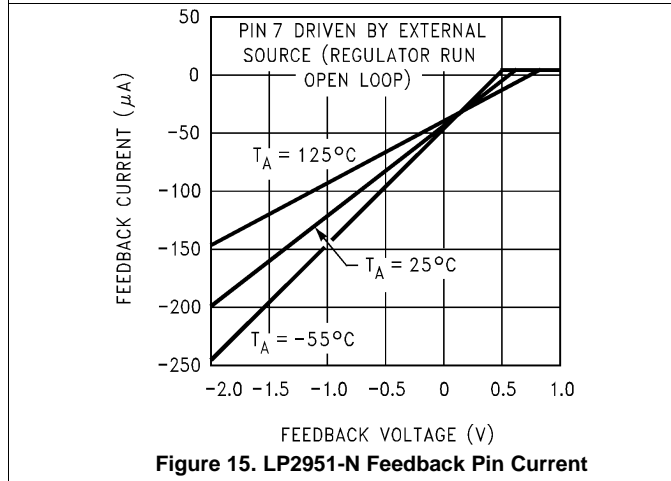
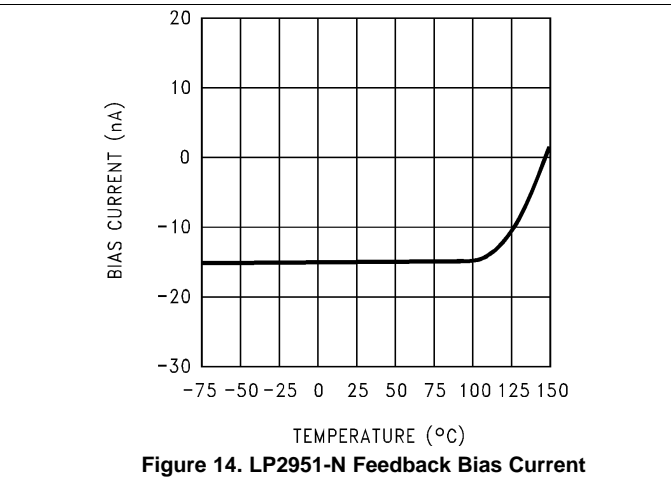
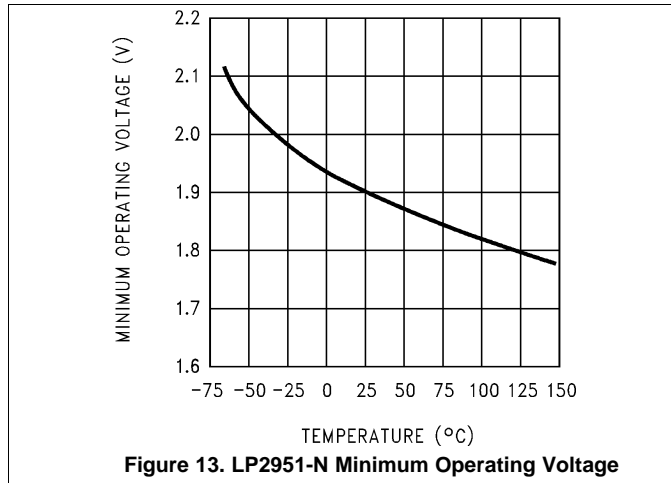
### 7.7 Typical Characteristics



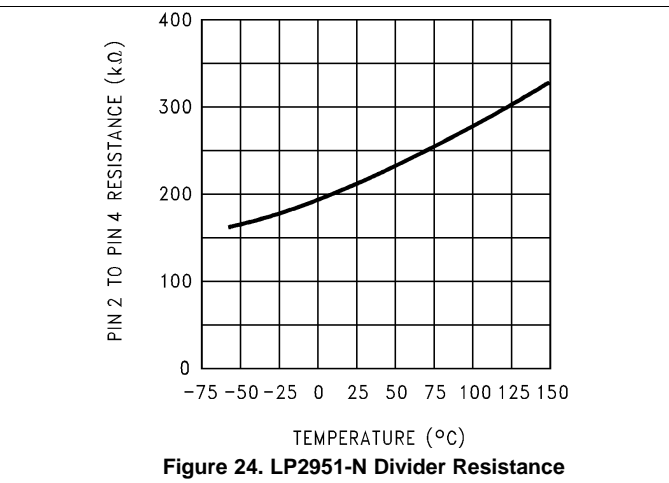
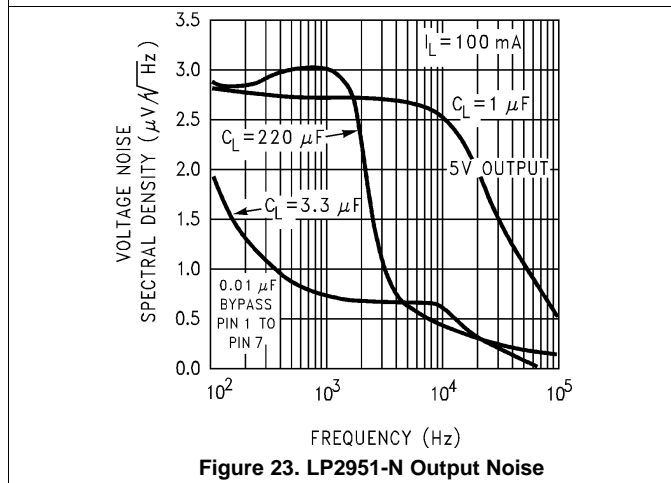
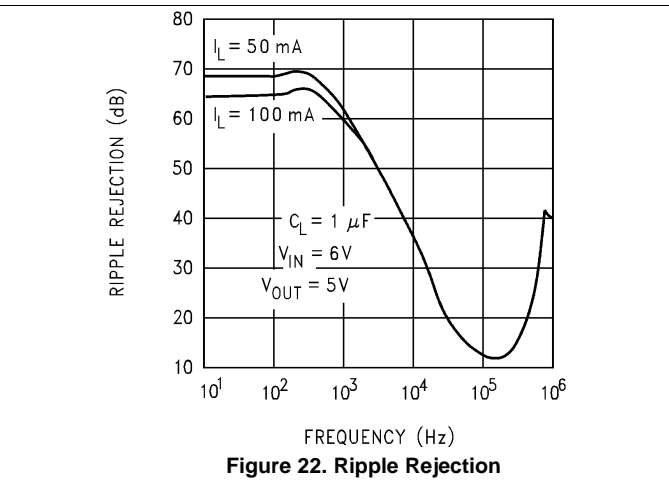
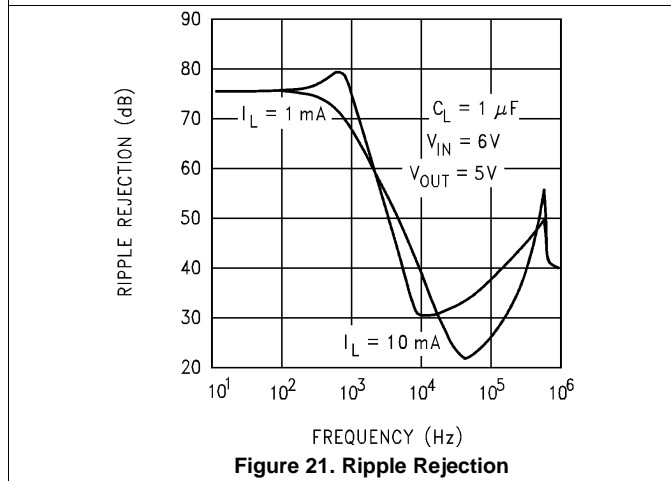
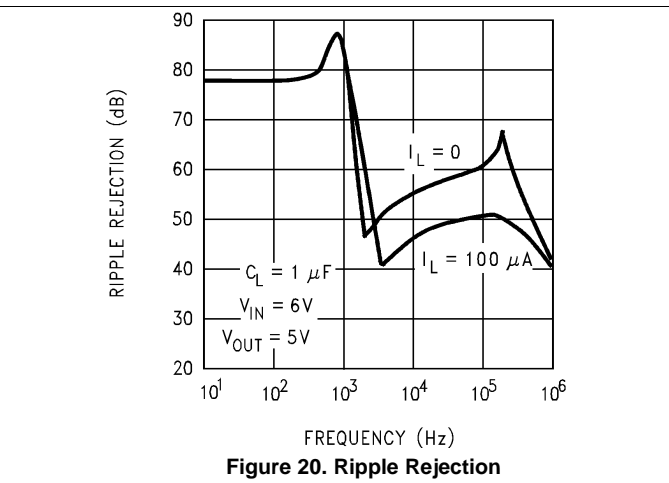
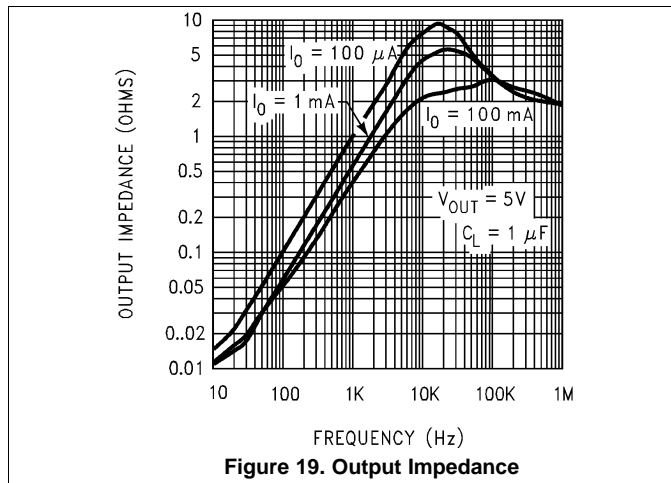
**Typical Characteristics (continued)**



Typical Characteristics (continued)



Typical Characteristics (continued)



Typical Characteristics (continued)

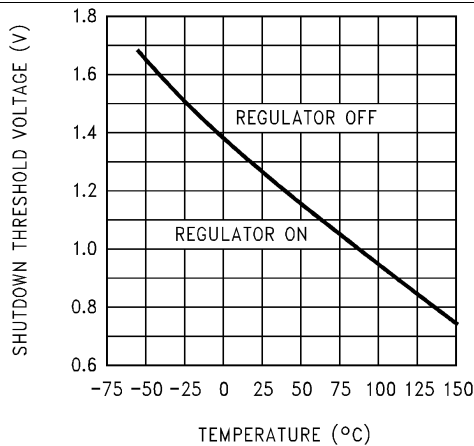


Figure 25. Shutdown Threshold Voltage

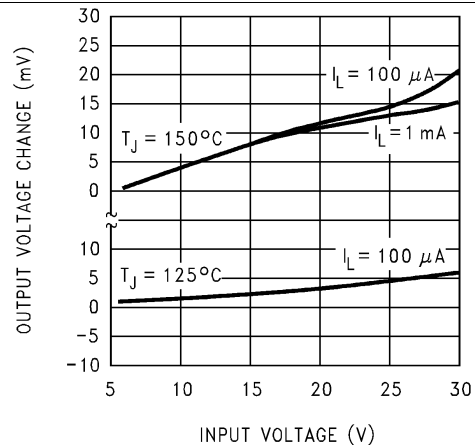


Figure 26. Line Regulation

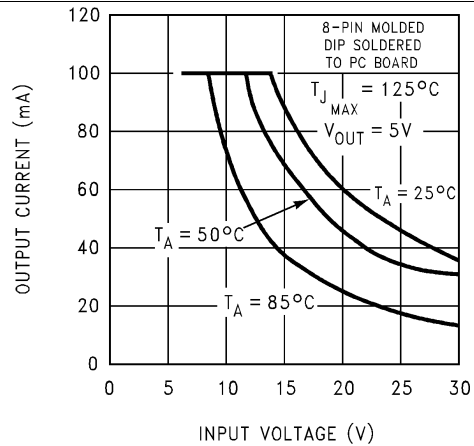


Figure 27. LP2951-N Maximum Rated Output Current

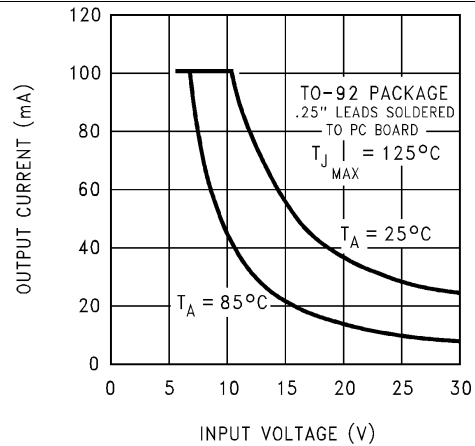


Figure 28. LP2950-N Maximum Rated Output Current

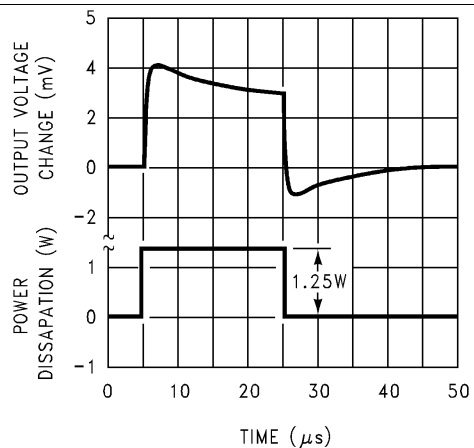


Figure 29. Thermal Response

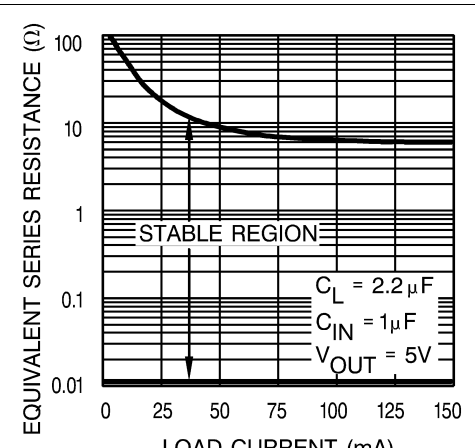
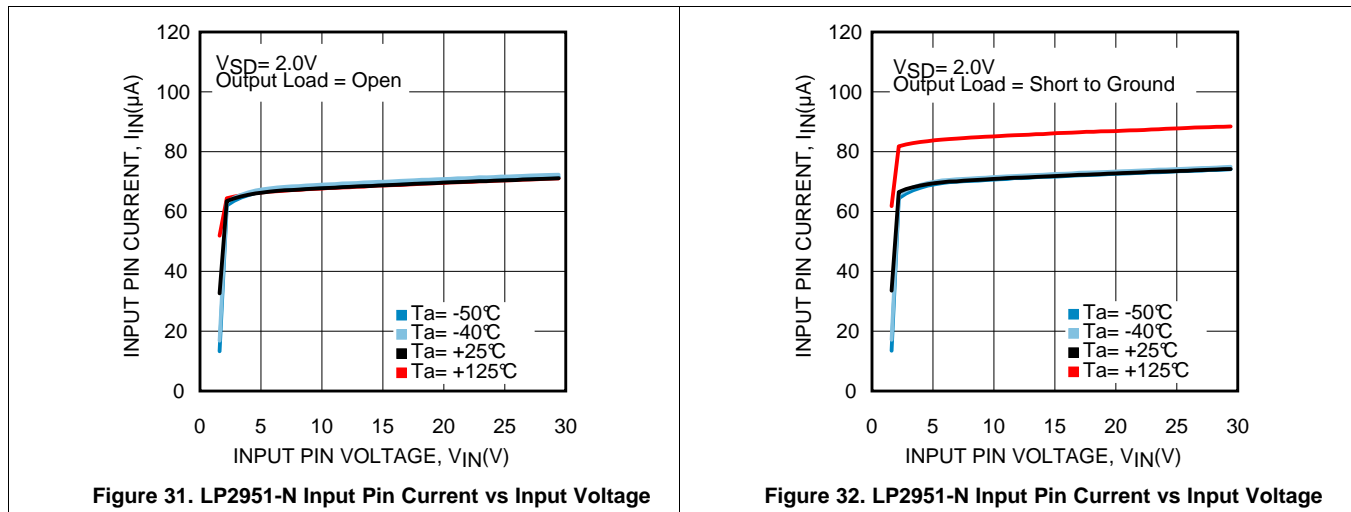


Figure 30. Output Capacitor ESR Range

Typical Characteristics (continued)



## 8 Detailed Description

### 8.1 Overview

The LP2950-N and LP2951-N are very high accuracy micro power voltage regulators with low quiescent current (75  $\mu$ A typical) and low dropout voltage (typical 40 mV at light loads and 380 mV at 100 mA). They are ideally suited for use in battery-powered systems.

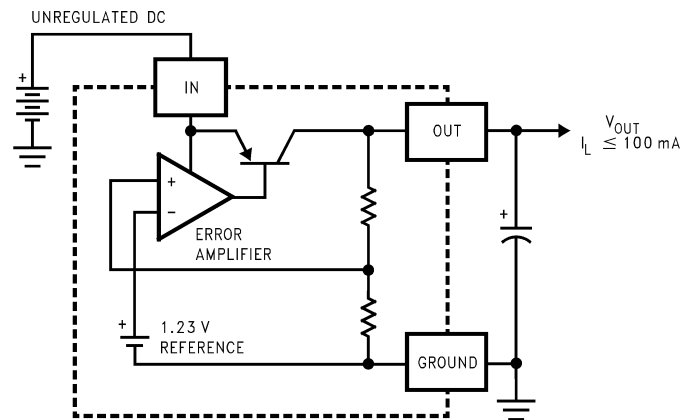
The LP2950-N and LP2951-N block diagram contains several features, including:

- Very high accuracy 1.23-V reference;
- Fixed 5-V, 3-V, and 3.3-V versions; and
- Internal protection circuitry, such as foldback current limit, and thermal shutdown.

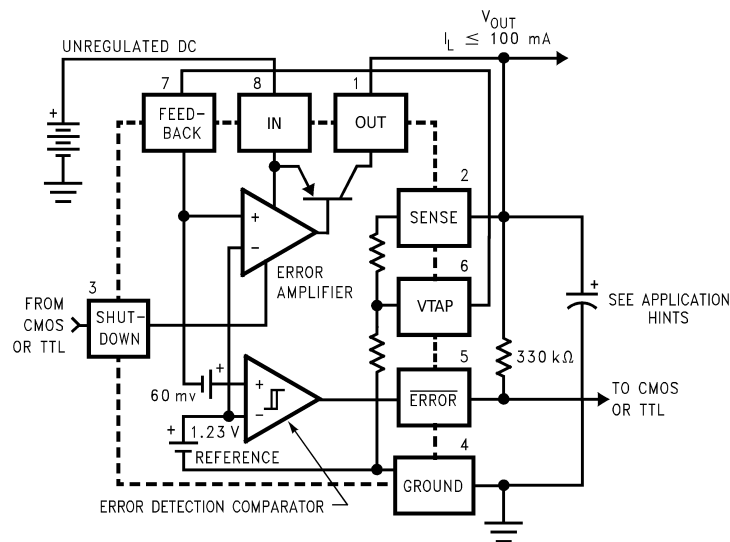
The LP2951-N VERSIONS ONLY:

- Fixed 5-V, 3-V, and 3.3-V versions and programmable output version from 1.24 V to 29 V with an external pair of resistors;
- Shutdown input, allowing turn off the regulator when the SHUTDOWN pin is pulled low; and
- Error flag output, which may be used for a power-on reset.

### 8.2 Functional Block Diagrams



**Figure 33. LP2950-N Functional Block Diagram**



**Figure 34. LP2951-N Functional Block Diagram**

## 8.3 Feature Description

### 8.3.1 Fixed Voltage Options and Programmable Voltage Version

The LP2950-N and LP2951-N provide 3 fixed output options: 3V, 3.3 V, and 5 V. Please consult factory for custom voltages. In order to meet different application requirements, LP2951-N can also be used as a programmable voltage regulator, with an external resistors network; please refer to [Application and Implementation](#) for more details.

### 8.3.2 High Accuracy Output Voltage

With special careful design to minimize all contributions to the output voltage error, the LP2950-N/LP2951-N distinguished itself as a very high output voltage accuracy micro power LDO. This includes a tight initial tolerance (0.5% typ.), extremely good load and line regulation (.05% typ.) and a very low output voltage temperature coefficient, making the part an ideal a low-power voltage reference.

### 8.3.3 Low Dropout Voltage

Generally speaking, the dropout voltage often refers to the voltage difference between the input and output voltage ( $V_{DO} = V_{IN} - V_{OUT}$ ), where the main current pass-FET is fully on in the ohmic region of operation and is characterized by the classic  $R_{DS(ON)}$  of the FET.  $V_{DO}$  indirectly specifies a minimum input voltage above the nominal programmed output voltage at which the output voltage is expected to remain within its accuracy boundary.

### 8.3.4 Shutdown Mode

When pull Shutdown pin to high level, LP2951-N will enter shutdown mode and a very low quiescent current is consumed. This function is designed for the application which needs a shutdown mode to effectively enhance battery life cycle.

### 8.3.5 Error Detection Comparator Output

The LP2951-N will generate a logic low output whenever its output falls out of regulation by more than approximately 5%. Please refer to [Application and Implementation](#) for more details.

### 8.3.6 Internal Protection Circuitry

#### 8.3.6.1 Short-Circuit Protection (Current Limit)

The internal current limit circuit is used to protect the LDO against high-load current faults or shorting events. The LDO is not designed to operate in a steady-state current limit. During a current-limit event, the LDO sources constant current. Therefore, the output voltage falls when load impedance decreases. Note also that if a current limit occurs and the resulting output voltage is low, excessive power may be dissipated across the LDO, resulting in a thermal shutdown of the output. A fold back feature limits the short-circuit current to protect the regulator from damage under all load conditions. If OUT is forced below 0 V before EN goes high and the load current required exceeds the fold back current limit, the device may not start up correctly.

#### 8.3.6.2 Thermal Protection

The device contains a thermal shutdown protection circuit to turn off the output current when excessive heat is dissipated in the LDO. The thermal time-constant of the semiconductor die is fairly short, and thus the output cycles on and off at a high rate when thermal shutdown is reached until the power dissipation is reduced. The internal protection circuitry of the device is designed to protect against thermal overload conditions. The circuitry is not intended to replace proper heat sinking. Continuously running the device into thermal shutdown degrades its reliability.

### 8.3.7 Enhanced Stability

The LP2950-N and LP2951-N is designed specifically to work with ceramic output capacitors, utilizing circuitry which allows the regulator to be stable across the entire range of output current with an output capacitor whose ESR is as low as 6 mΩ. For output capacitor requirement, please refer to [Application and Implementation](#).



## 8.4 Device Functional Modes

### 8.4.1 Operation with $30\text{ V} \geq V_{\text{IN}} > V_{\text{OUT(TARGET)}} + 1\text{ V}$

The device operate if the input voltage is equal to, or exceeds  $V_{\text{OUT(TARGET)}} + 1\text{ V}$ . At input voltages below the minimum  $V_{\text{IN}}$  requirement, the devices do not operate correctly and output voltage may not reach target value.

### 8.4.2 Operation with Shutdown Control

If the voltage on the SHUTDOWN pin is higher than 1.3 V, the device is disabled. Decreasing shutdown below 0.7 V initiates the start-up sequence of the device.

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The LP2950-N and LP2951-N are linear voltage regulator operating from 2.3 V to 30 V on the input and regulates voltages between 1.24 V to 29 V with 0.5% accuracy and 160 mA maximum outputs current. Efficiency is defined by the ratio of output voltage to input voltage because the LP2950-N and LP2951-N is a linear voltage regulator. To achieve high efficiency, the dropout voltage ( $V_{IN} - V_{OUT}$ ) must be as small as possible, thus requiring a very low dropout LDO. Successfully implementing an LDO in an application depends on the application requirements. If the requirements are simply input voltage and output voltage, compliance specifications (such as internal power dissipation or stability) must be verified to ensure a solid design. If timing, start-up, noise, PSRR, or any other transient specification is required, the design becomes more challenging.

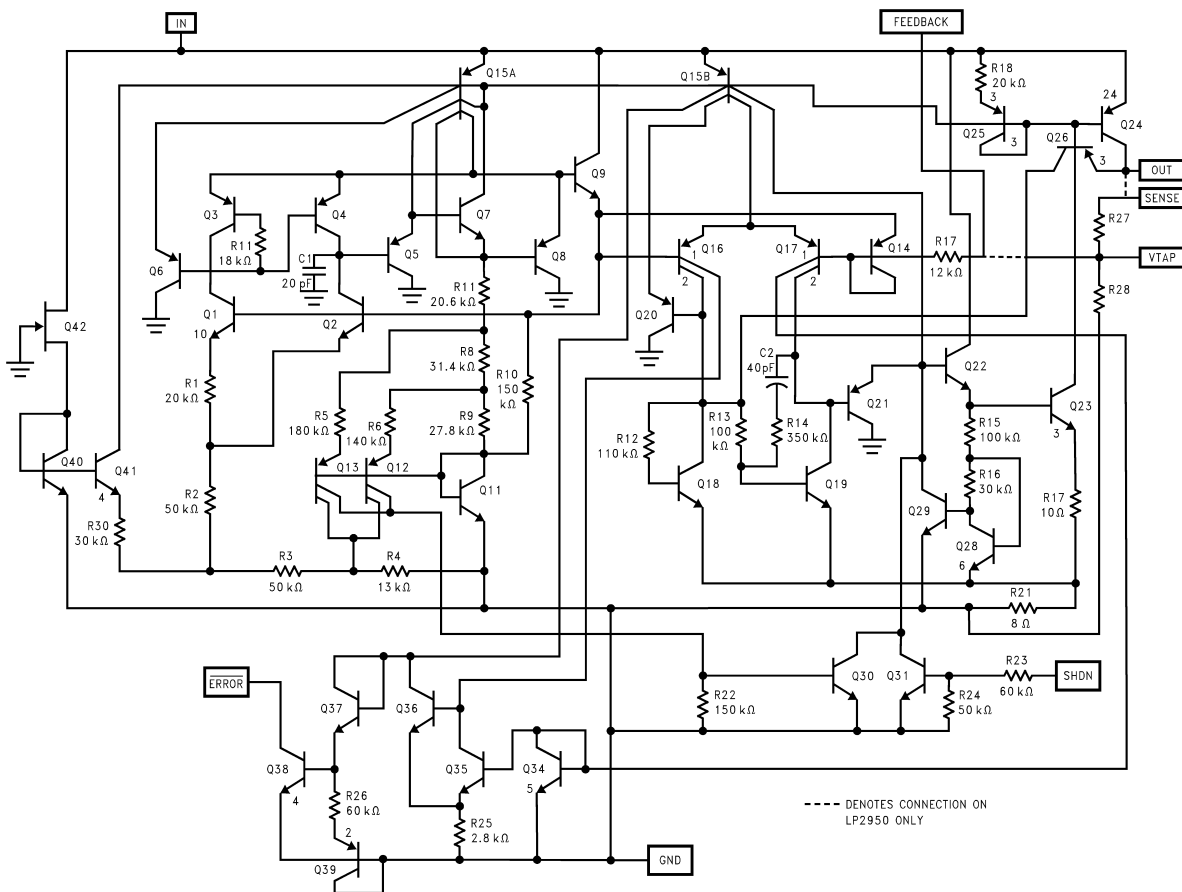


Figure 35. Schematic Diagram

## 9.2 Typical Applications

### 9.2.1 1-A Regulator with 1.2-V Dropout

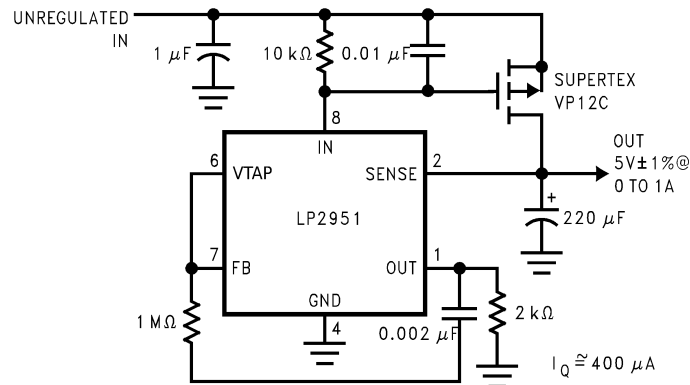


Figure 36. 1-A Regulator with 1.2-V Dropout

#### 9.2.1.1 Design Requirements

For this design example, use the parameters listed in Table 1 as the input parameters.

Table 1. Design Parameters

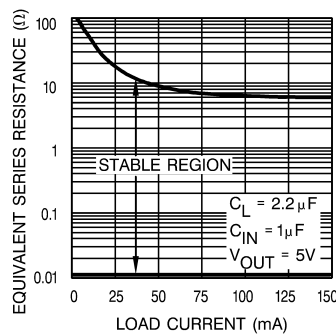
DESIGN PARAMETER	DESIGN REQUIREMENT
Input voltage	6.5 V, $\pm 10\%$ , provided by the DC-DC converter switching at 1 MHz
Output voltage	5 V, $\pm 1\%$
Output current	100 mA (maximum), 1 mA (minimum)
RMS noise, 10 Hz to 100 kHz	< 200 $\mu\text{V}_{\text{rms}}$
PSRR at 1 KHz	> 50 dB

#### 9.2.1.2 Detailed Design Procedure

At 100-mA loading, the dropout of the LP2950-N/LP2951-N has 600 mV maximum dropout over temperature, thus an 1500-mV headroom is sufficient for operation over both input and output voltage accuracy. The efficiency of the LP2950-N/LP2951-N in this configuration is  $V_{\text{OUT}} / V_{\text{IN}} = 76.9\%$ . To achieve the smallest form factor, the TO-92 package is selected. Input and output capacitors are selected in accordance with the Capacitor Recommendation section. Ceramic capacitances of 1  $\mu\text{F}$  for the input and one 2.2- $\mu\text{F}$  capacitors for the output are selected. With an efficiency of 73.3% and a 100-mA maximum load, the internal power dissipation is 150 mW, which corresponds to a 18.9°C junction temperature rise for the TO-92 package. With an 85°C maximum ambient temperature, the junction temperature is at 103.9°C. To minimize noise, a bypass capacitance ( $C_{\text{BYPASS}}$ ) of 0.01- $\mu\text{F}$  is selected between pin 7 to pin 1 for LP2951-N.

##### 9.2.1.2.1 Output Capacitor Requirements

A 1- $\mu\text{F}$  (or greater) capacitor is required between the output and ground for stability at output voltages of 5 V or higher. At lower output voltages, more capacitance is required (2.2  $\mu\text{F}$  or more is recommended for 3-V and 3.3-V versions). Without this capacitor the part will oscillate. Most types of tantalum or aluminum electrolytic work fine here; even film types work but are not recommended for reasons of cost. Many aluminum electrolytics have electrolytes that freeze at about  $-30^\circ\text{C}$ , so solid tantalums are recommended for operation below  $-25^\circ\text{C}$ . The important parameters of the capacitor are an ESR of about 5  $\Omega$  or less and a resonant frequency above 500 kHz. The value of this capacitor may be increased without limit.



**Figure 37. Output Capacitor ESR Range**

The reason for the lower ESR limit is that the loop compensation of the feedback loop relies on the capacitance value and the ESR value of the output capacitor to provide the zero that gives added phase lead (See Figure 37).

$$f_z = (1 / (2 \times \pi \times C_{OUT} \times ESR)) \tag{1}$$

Using the 2.2  $\mu\text{F}$  value from the *Output Capacitor ESR Range* curve (Figure 37), a useful range for  $f_z$  can be estimated:

$$f_{z(MIN)} = (1 / (2 \times \pi \times 2.2 \mu\text{F} \times 5 \Omega)) = 14.5 \text{ kHz} \tag{2}$$

$$f_{z(MAX)} = (1 / (2 \times \pi \times 2.2 \mu\text{F} \times 0.05 \Omega)) = 318 \text{ kHz} \tag{3}$$

For ceramic capacitors, the low ESR produces a zero at a frequency that is too high to be useful, so meaningful phase lead does not occur. A ceramic output capacitor can be used if a series resistance is added (recommended value of resistance about 0.1  $\Omega$  to 2  $\Omega$ ) to simulate the needed ESR. Only X5R, X7R, or better, MLCC types should be used, and should have a DC voltage rating at least twice the  $V_{OUT(NOM)}$  value.

At lower values of output current, less output capacitance is required for stability. The capacitor can be reduced to 0.33  $\mu\text{F}$  for currents below 10 mA or 0.1  $\mu\text{F}$  for currents below 1 mA. Using the adjustable versions at voltages below 5 V runs the error amplifier at lower gains so that *more* output capacitance is needed. For the worst-case situation of a 100-mA load at 1.23 V output (output shorted to Feedback) a 3.3- $\mu\text{F}$  (or greater) capacitor should be used.

Unlike many other regulators, the LP2950-N will remain stable and in regulation with no load in addition to the internal voltage divider. This is especially important in CMOS RAM keep-alive applications. When setting the output voltage of the LP2951-N versions with external resistors, a minimum load of 1  $\mu\text{A}$  is recommended.

Applications having conditions that may drive the LP2950-N/51 into nonlinear operation require special consideration. Nonlinear operation will occur when the output voltage is held low enough to force the output stage into output current limiting while trying to pull the output voltage up to the regulated value. The internal loop response time will control how long it takes for the device to regain linear operation when the output has returned to the normal operating range. There are three significant nonlinear conditions that need to be considered, all can force the output stage into output current limiting mode, all can cause the output voltage to over-shoot with low value output capacitors when the condition is removed, and the recommended generic solution is to set the output capacitor to a value not less than 10  $\mu\text{F}$ . Although the 10  $\mu\text{F}$  value for  $C_{OUT}$  may not eliminate the output voltage over-shoot in all cases, it should lower it to acceptable levels (< 10% of  $V_{OUT(NOM)}$ ) in the majority of cases. In all three of these conditions, applications with lighter load currents are more susceptible to output voltage over-shoot than applications with higher load currents.

1. At power-up, with the input voltage rising faster than output stage can charge the output capacitor.

$$V_{IN} t_{RISE(MIN)} > ((C_{OUT} / 100 \text{ mA}) \times \Delta V_{IN})$$

where

- $\Delta V_{IN} = V_{OUT(NOM)} + 1 \text{ V}$  (4)

2. Recovery from an output short circuit to ground condition.

$$C_{OUT(MIN)} \approx (160 \text{ mA} - I_{LOAD(NOM)}) / ((V_{OUT(NOM)} / 10) / 25 \mu\text{s}) \tag{5}$$

3. Toggling the LP2951-N SHUTDOWN pin from high (OFF) to low (ON).

$$C_{OUT(MIN)} \approx (160 \text{ mA} - I_{LOAD(NOM)}) / ((V_{OUT(NOM)} / 10) / 25 \mu\text{s}) \tag{6}$$

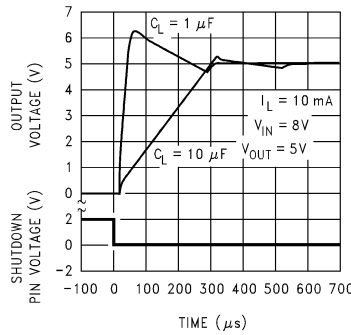


Figure 38. LP2951-N Enable Transient

### 9.2.1.2.2 Input Capacitor Requirements

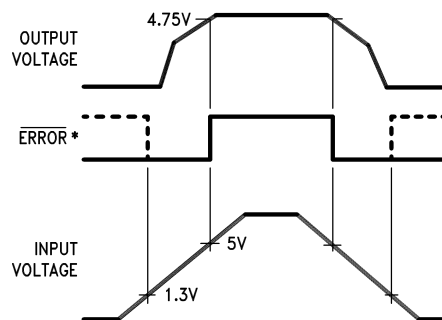
A minimum 1  $\mu\text{F}$  tantalum, ceramic or aluminum electrolytic capacitor should be placed from the LP2950-N/LP2951-N input pin to ground if there is more than 10 inches of wire between the input and the AC filter capacitor or if a battery is used as the input.

### 9.2.1.2.3 Error Detection Comparator Output

The comparator produces a logic low output whenever the LP2951-N output falls out of regulation by more than approximately 5%. This figure is the comparator's built-in offset of about 60 mV divided by the 1.235 reference voltage. (Refer to the block diagram in the front of the datasheet.) This trip level remains "5% below normal" regardless of the programmed output voltage of the 2951. For example, the error flag trip level is typically 4.75 V for a 5-V output or 11.4 V for a 12-V output. The out of regulation condition may be due either to low input voltage, current limiting, or thermal limiting.

Figure 39 below gives a timing diagram depicting the  $\overline{\text{ERROR}}$  signal and the regulated output voltage as the LP2951-N input is ramped up and down. For 5 V versions, the  $\overline{\text{ERROR}}$  signal becomes valid (low) at about 1.3-V input. It goes high at about 5-V input (the input voltage at which  $V_{\text{OUT}} = 4.75 \text{ V}$ ). Since the LP2951-N dropout voltage is load-dependent (see curve in typical performance characteristics), the **input** voltage trip point (about 5 V) will vary with the load current. The **output** voltage trip point (approx. 4.75 V) does not vary with load.

The error comparator has an open-collector output which requires an external pull up resistor. This resistor may be returned to the output or some other supply voltage depending on system requirements. In determining a value for this resistor, note that while the output is rated to sink 400  $\mu\text{A}$ , this sink current adds to battery drain in a low battery condition. Suggested values range from 100 k to 1 M $\Omega$ . The resistor is not required if this output is unused.



\*When  $V_{\text{IN}} \leq 1.3 \text{ V}$ , the error flag pin becomes a high impedance, and the error flag voltage rises to its pull-up voltage. Using  $V_{\text{OUT}}$  as the pull-up voltage (see Figure 40), rather than an external 5-V source, will keep the error flag voltage under 1.2 V (typ.) in this condition. The user may wish to divide down the error flag voltage using equal-value resistors (10 k $\Omega$  suggested), to ensure a low-level logic signal during any fault condition, while still allowing a valid high logic level during normal operation.

Figure 39.  $\overline{\text{ERROR}}$  Output Timing

### 9.2.1.2.4 Programming the Output Voltage (LP2951-N)

The LP2951-N may be pin-strapped for the nominal fixed output voltage using its internal voltage divider by tying the output and sense pins together, and also tying the FEEDBACK and VTAP pins together. Alternatively, it may be programmed for any output voltage between its 1.235-V reference and its 30-V maximum rating. As seen in Figure 40, an external pair of resistors is required.

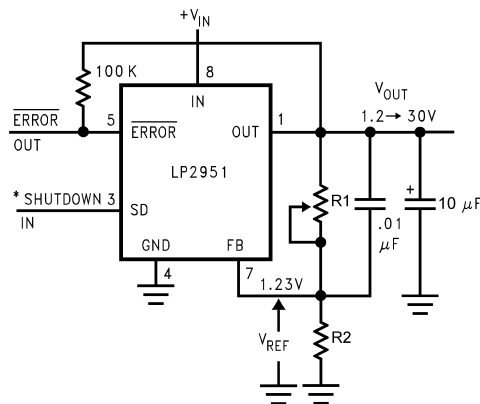
The complete equation for the output voltage is

$$V_{OUT} = V_{REF} \cdot \left( 1 + \frac{R_1}{R_2} \right) + I_{FB}R_1$$

where

- $V_{REF}$  is the nominal 1.235-V reference voltage and  $I_{FB}$  is the feedback pin bias current, nominally  $-20$  nA (7)

The minimum recommended load current of  $1 \mu\text{A}$  forces an upper limit of  $1.2 \text{ M}\Omega$  on the value of  $R_2$ , if the regulator must work with no load (a condition often found in CMOS in standby).  $I_{FB}$  will produce a 2% typical error in  $V_{OUT}$  which may be eliminated at room temperature by trimming  $R_1$ . For better accuracy, choosing  $R_2 = 100 \text{ k}\Omega$  reduces this error to 0.17% while increasing the resistor program current to  $12 \mu\text{A}$ . Since the LP2951-N typically draws  $60 \mu\text{A}$  at no load with Pin 2 open-circuited, this is a small price to pay.



$$V_{out} = V_{Ref} \left( 1 + \frac{R_1}{R_2} \right)$$

\*Drive with TTL-high to shut down. Ground or leave open if shutdown feature is not to be used.

**Note:** Pins 2 and 6 are left open.

**Figure 40. Adjustable Regulator**

Stray capacitance to the LP2951-N Feedback terminal can cause instability. This may especially be a problem when using high value external resistors to set the output voltage. Adding a 100-pF capacitor between the Output pin and the Feedback pin, and increasing the output capacitor to at least  $3.3 \mu\text{F}$ , will fix this problem.

### 9.2.1.2.5 Reducing Output Noise

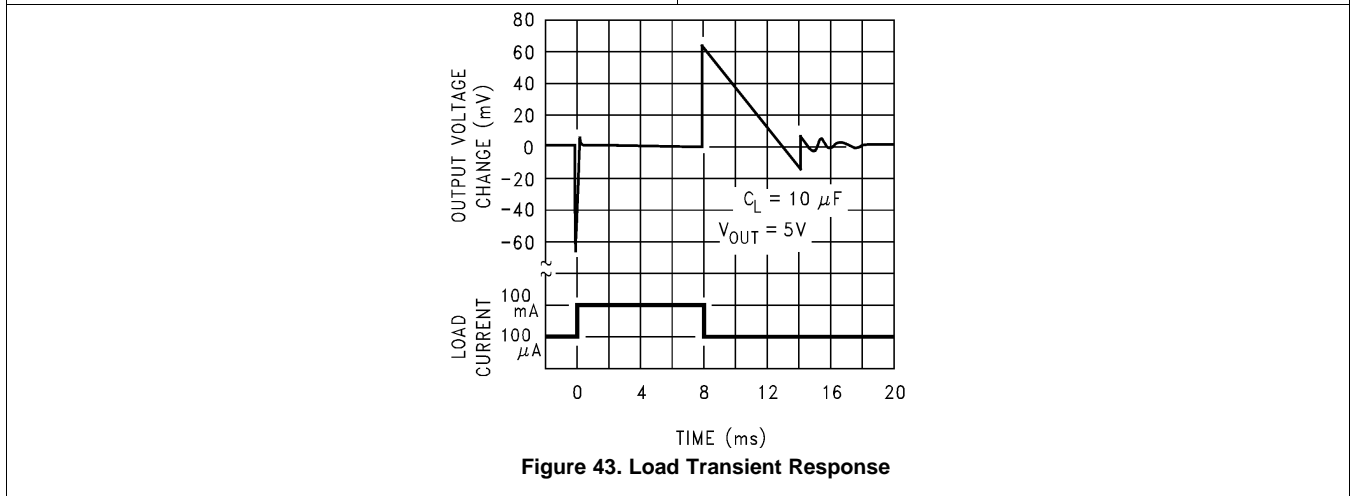
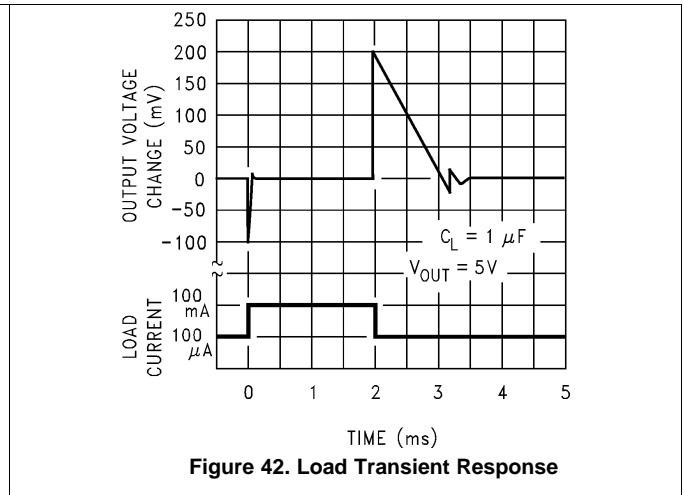
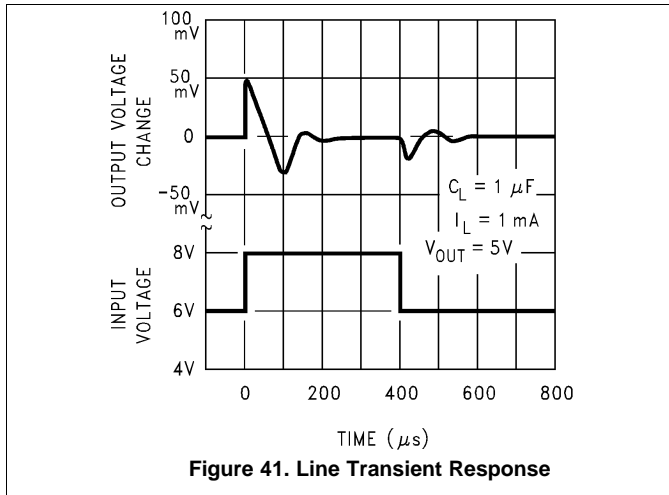
In reference applications it may be advantageous to reduce the AC noise present at the output. One method is to reduce the regulator bandwidth by increasing the size of the output capacitor. This is the only way noise can be reduced on the 3-lead LP2950-N but is relatively inefficient, as increasing the capacitor from  $1 \mu\text{F}$  to  $220 \mu\text{F}$  only decreases the noise from  $430 \mu\text{V}_{(RMS)}$  to  $160 \mu\text{V}_{(RMS)}$  for a 100-kHz bandwidth at 5-V output.

Noise can be reduced fourfold by a bypass capacitor across  $R_1$ , since it reduces the high frequency gain from 4 to unity. Pick

$$C_{BYPASS} \cong \frac{1}{2\pi R_1 \bullet 200 \text{ Hz}} \tag{8}$$

or about  $0.01 \mu\text{F}$ . When doing this, the output capacitor must be increased to  $3.3 \mu\text{F}$  to maintain stability. These changes reduce the output noise from  $430 \mu\text{V}$  to  $100 \mu\text{V}$  rms for a 100-kHz bandwidth at 5-V output. With the bypass capacitor added, noise no longer scales with output voltage so that improvements are more dramatic at higher output voltages.

**9.2.1.3 Application Curves**



### 9.2.2 300-mA Regulator with 0.75-V Dropout

In Figure 44, by paralleling the LP2951 together with 2x2N5432 (150mA N channel JFET), we can get a higher output current capability around 300mA.

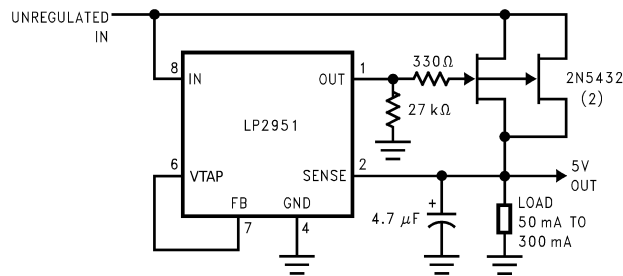
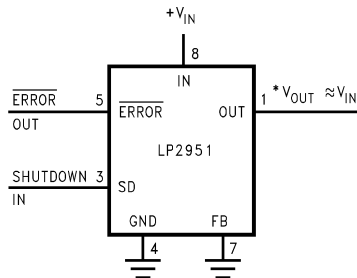


Figure 44. 300-mA Regulator with 0.75-V Dropout

### 9.2.3 Wide Input Voltage Range Current Limiter

The LP2951 can be used as a 160-mA current limiter as Figure 45. When we connect FB to ground, the pass element is fully turned on and out voltage will be close to input voltage. Input-output voltage ranges from 40 mV to 400 mV, depending on load current.



\*Minimum input-output voltage ranges from 40 mV to 400 mV, depending on load current. Current limit is typically 160 mA.

Figure 45. Wide Input Voltage Range Current Limiter



### 9.2.4 Low Drift Current Source

The LP2951 can be used as a low drift current source as [Figure 46](#) shows. By connected  $V_{out}$  to FB,  $V_{out}$  will regulated at 1.235 V, and current consumption at R is  $I_L = 1.23/R$ .

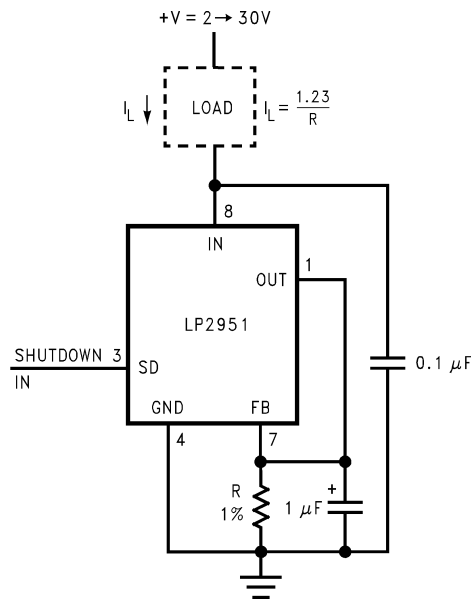
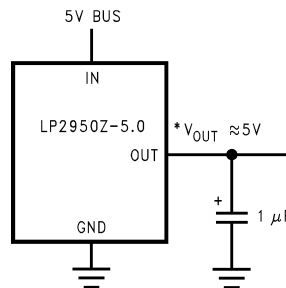


Figure 46. Low Drift Current Source

### 9.2.5 5-V Current Limiter

We can leverage the LP2950 internal current limit function to build 5-V current limiter as [Figure 47](#) shows. The minimum input-output voltage ranges from 40 mV to 400 mV, depending on load current. Current limit is typically 160 mA.



\*Minimum input-output voltage ranges from 40 mV to 400 mV, depending on load current. Current limit is typically 160 mA.

Figure 47. 5-V Current Limiter

### 9.2.6 Regulator with Early Warning and Auxiliary Output

The LP2951 can be used to build a Regulator with Early Warning and Auxiliary Output as Figure 48 shows. It has the following features:

- Early warning flag on low input voltage
- Main output latches off at lower input voltages
- Battery backup on auxiliary output
- Operation:  $V_{OUT}$  of regulator 1 is programmed one diode drop above 5 V. Its error flag becomes active when  $V_{IN} \leq 5.7$  V. When  $V_{IN}$  drops below 5.3 V, the error flag of regulator 2 becomes active and via Q1 latches the main output off. When  $V_{IN}$  again exceeds 5.7 V regulator 1 is back in regulation and the early warning signal rises, unlatching regulator 2 via D3.

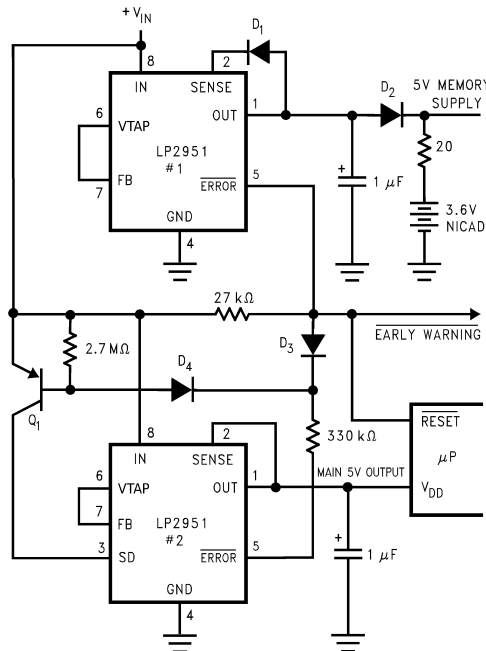


Figure 48. Regulator with Early Warning and Auxiliary Output

### 9.2.7 Latch Off When Error Flag Occurs

As Figure 49 presents, a latch off when error flag occurs circuit works in below two mode:

When output is within  $\pm 95\%$  of  $V_{OUT}$  option, the error flag pin keep output high, which will turn off PNP bipolar and pull SD pin to low, then the LP2951 keeps output regulated voltage.

When output drop to less than 95% of  $V_{OUT}$  option, it will trigger error flag output a low voltage, which will turn on PNP bipolar and pull SD pin to high, then chip enter shutdown mode and turn off output voltage. During shutdown sequence, error pin will continue output low and the LP2951 latched in shutdown mode.

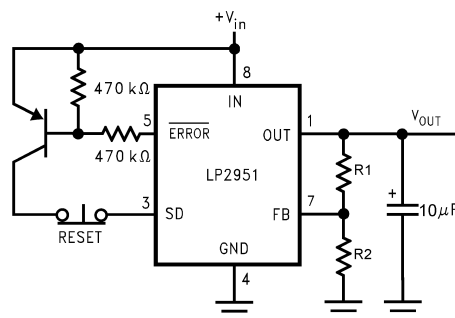


Figure 49. Latch Off When Error Flag Occurs

### 9.2.8 2-A Low Dropout Regulator

As Figure 50 shows, the 2-A Low Dropout Regulator has below features:

$$V_{out} = 1.23V \left( 1 + \frac{R_1}{R_2} \right)$$

For 5 V<sub>OUT</sub>, use internal resistors. Wire pin 6 to pin 7 and wire pin 2 to + V<sub>OUT</sub> bus.

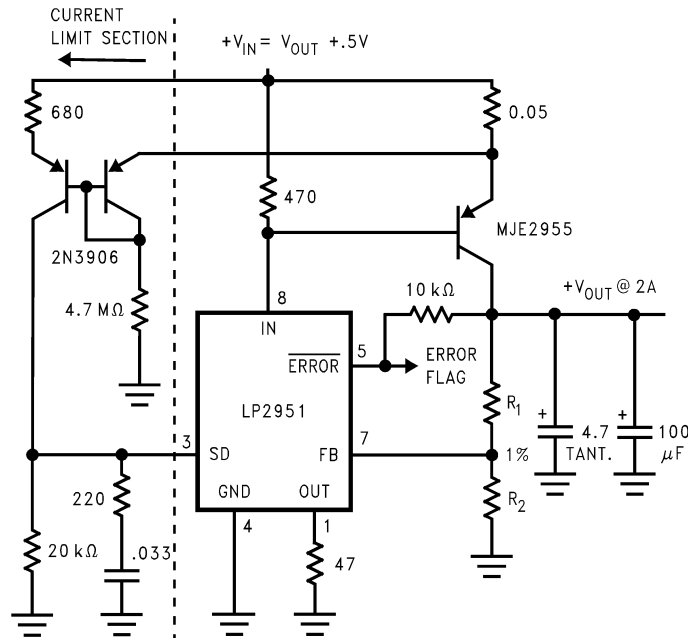


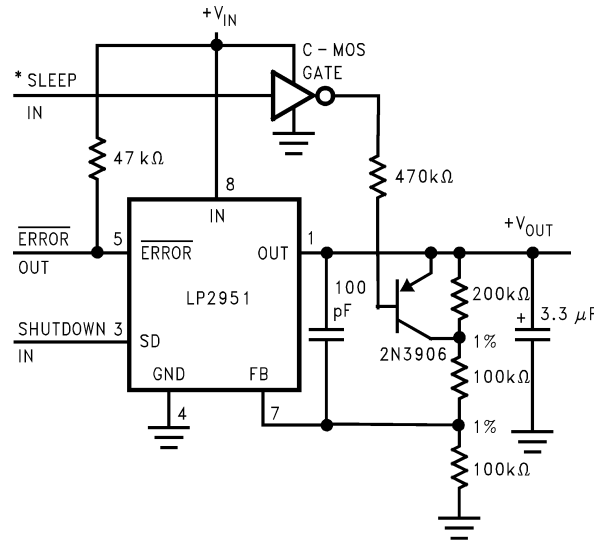
Figure 50. 2-A Low Dropout Regulator

### 9.2.9 5-V Regulator with 2.5-V Sleep Function

In Figure 51, the 5-V Regulator with 2.5-V Sleep Function works in below mode:

When sleep input is low, C-MOS output a high voltage and 2N3906 is off, then  $V_{out} = (1 + 300\text{ K}\Omega/100\text{ K}\Omega) \times V_{FB} \approx 5\text{ V}$

when sleep input is high, C-MOS output a low voltage, turns on 2N3906, then 200 KΩ resistor is bypassed from circuit, and  $V_{out} = (1+100\text{ K}\Omega/100\text{ K}\Omega) \times V_{FB} \approx 2.5\text{ V}$ .



\*High input lowers  $V_{out}$  to 2.5 V.

Figure 51. 5-V Regulator with 2.5-V Sleep Function

### 9.2.10 Open Circuit Detector for 4 → 20-mA Current Loop

Figure 52 shows the open circuit detector for 4 → 20-mA current loop. The circuit will output a high level while input current is less than 3.5 mA.

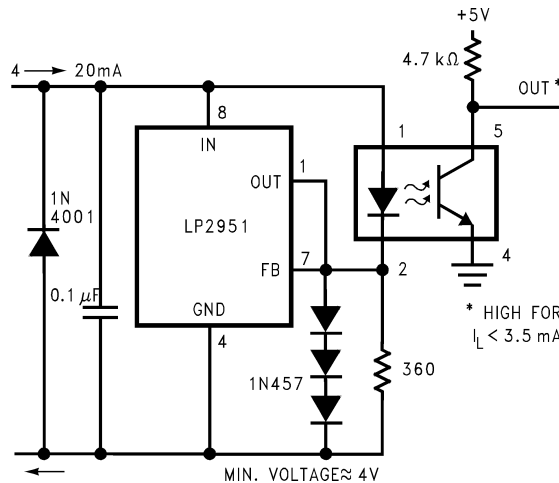
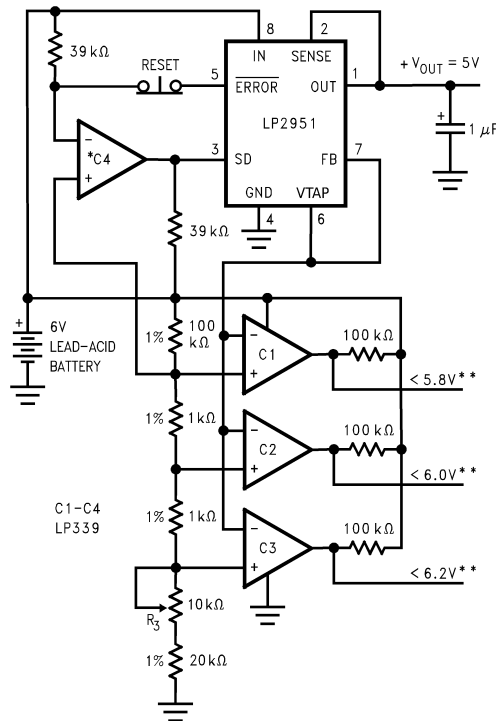


Figure 52. Open Circuit Detector for 4 → 20-mA Current Loop

### 9.2.11 Regulator with State-of-Charge Indicator

In Figure 53, we use LP339, a quad comparator, to indicate battery voltage state. The comparator's negative input voltage is equal to the LP2951 1.235-V feedback voltage. By adjusting R3, we can adjust positive input voltage of C1~C3 to target value.



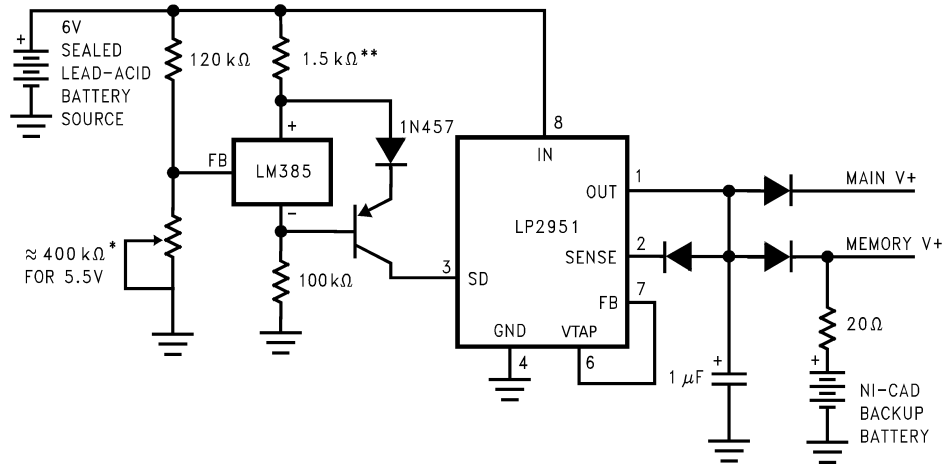
\*Optional latch off when drop out occurs. Adjust R3 for C2 Switching when  $V_{in}$  is 6 V.

\*\*Outputs go low when  $V_{in}$  drops below designated thresholds.

**Figure 53. Regulator with State-of-Charge Indicator**

### 9.2.12 Low Battery Disconnect

In Figure 54, a band-gap voltage reference LM385 is used to generate shutdown signal, when  $V_{in} < 5.5\text{ V}$ , the LP2951 turns off and turns on again when  $V_{in} > 6\text{ V}$ .



For values shown, regulator shuts down when  $V_{in} < 5.5\text{ V}$  and turns on again at  $6\text{ V}$ . Current drain in disconnected mode is approximately  $150\text{ }\mu\text{A}$ .

\*Sets disconnect voltage.

\*\*Sets disconnect hysteresis.

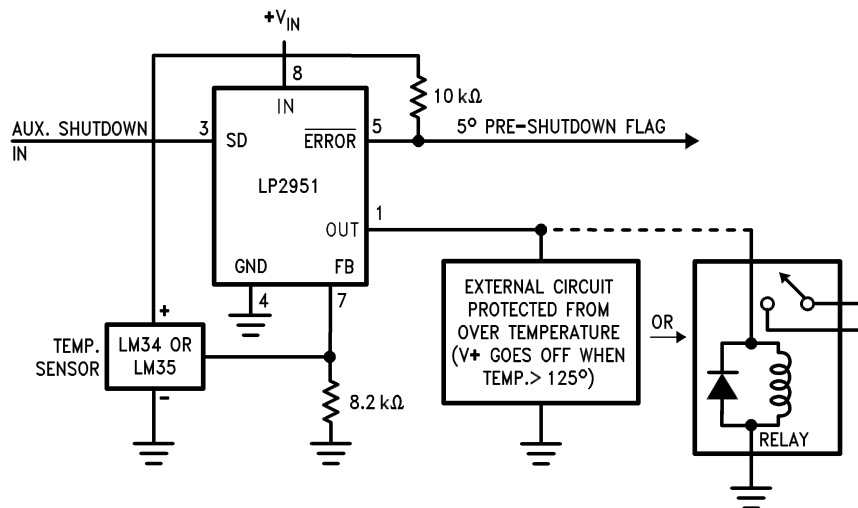
Figure 54. Low Battery Disconnect

### 9.2.13 System Overtemperature Protection Circuit

In Figure 55, temperature sensors LM34/35's output voltage is linearly proportional to the Celsius (Centigrade) temperature.

At room temperature, LM34/35's output voltage is lower than  $1.235\text{-V}$  feedback voltage, the internal pass transistor fully turns on, LP2951 output voltage is close to  $V_{in}$ .

When ambient temperature raise higher than protection target, LM34/35's output voltage will be higher than  $1.235\text{-V}$  feedback voltage, the internal pass transistor turns off, the LP2951 output will go off.



LM34 for  $125^{\circ}\text{F}$  Shutdown

LM35 for  $125^{\circ}\text{C}$  Shutdown

Figure 55. System Overtemperature Protection Circuit

## 10 Power Supply Recommendations

The LP2950-N and LP2951-N are designed to operate from an input voltage supply range between 2.3 V and 30 V. The input voltage range provides adequate headroom in order for the device to have a regulated output. This input supply must be well regulated. If the input supply is noisy, additional input capacitors with low ESR can help improve the output noise performance.

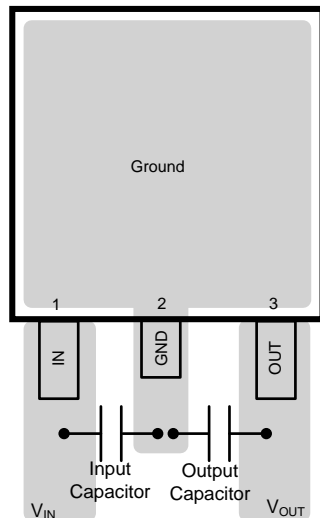
## 11 Layout

### 11.1 Layout Guidelines

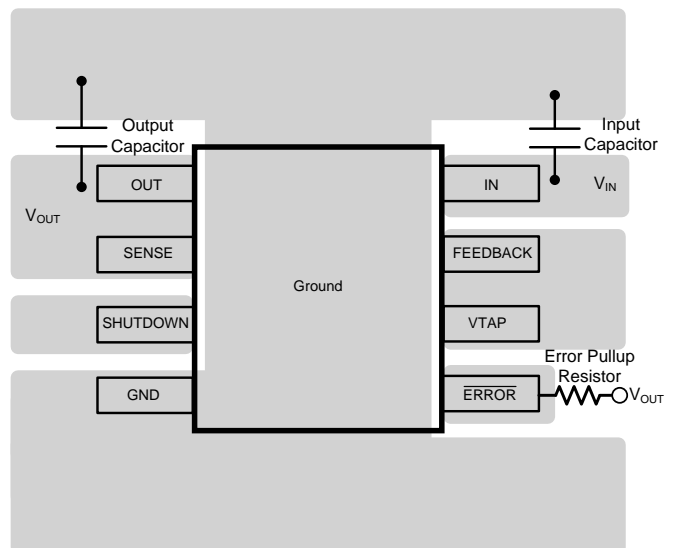
For best overall performance, place all circuit components on the same side of the circuit board and as near as practical to the respective LDO pin connections. Place ground return connections to the input and output capacitor, and to the LDO ground pin as close to each other as possible, connected by a wide, component-side, copper surface. The use of vias and long traces to create LDO circuit connections is strongly discouraged and negatively affects system performance. This grounding and layout scheme minimizes inductive parasitics, and thereby reduces load-current transients, minimizes noise, and increases circuit stability.

A ground reference plane is also recommended and is either embedded in the PCB itself or located on the bottom side of the PCB opposite the components. This reference plane serves to assure accuracy of the output voltage, shield noise, and behaves similar to a thermal plane to spread (or sink) heat from the LDO device. In most applications, this ground plane is necessary to meet thermal requirements.

### 11.2 Layout Example



**Figure 56. LP2950 Board Layout**



**Figure 57. LP2951 Board Layout**

### 11.3 WSON Mounting

The NGT (No Pullback) 8-Lead WSON package requires specific mounting techniques which are detailed in TI Application Note 1187, *Leadless Leadframe Package (LLP) (SNOA401)*. Referring to the PCB Design Recommendations section, it should be noted that the pad style which should be used with the WSON package is the NSMD (non-solder mask defined) type. Additionally, it is recommended the PCB terminal pads to be 0.2 mm longer than the package pads to create a solder fillet to improve reliability and inspection.

The thermal dissipation of the WSON package is directly related to the printed circuit board construction and the amount of additional copper area connected to the DAP.

For the LP2951-N in the NGT 8-Lead WSON package, the junction-to-case thermal rating,  $R_{\theta JC}$ , is 35°C/W, where the case is the bottom of the package at the center of the DAP.

### WSON Mounting (continued)

The DAP (exposed pad) on the bottom of the WSON package is connected to the die substrate with a conductive die attach adhesive. The DAP has no direct electrical (wire) connection to any of the eight pins. There is a parasitic PN junction between the die substrate and the device ground. As such, it is strongly recommended that the DAP be connected directly to the ground at device lead 4 (that is, GND). Alternately, but not recommended, the DAP may be left floating (that is, no electrical connection). The DAP must not be connected to any potential other than ground.



## 12 Device and Documentation Support

### 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation, see the following:

TI Application Note 1187, *Leadless Leadframe Package (LLP)* ([SNOA401](#)).

### 12.2 Related Links

[Table 2](#) lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 2. Related Links**

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
LP2950-N	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>
LP2951-N	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>

### 12.3 Trademarks

All trademarks are the property of their respective owners.

### 12.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2950ACZ-3.0/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	2950A CZ3.0	<a href="#">Samples</a>
LP2950ACZ-3.3/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	2950A CZ3.3	<a href="#">Samples</a>
LP2950ACZ-5.0/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950A CZ5.0	<a href="#">Samples</a>
LP2950ACZ-5.0/LFT3	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950A CZ5.0	<a href="#">Samples</a>
LP2950ACZ-5.0/LFT7	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU	N / A for Pkg Type		2950A CZ5.0	<a href="#">Samples</a>
LP2950ACZ-5.0/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU	N / A for Pkg Type	-40 to 125	2950A CZ5.0	<a href="#">Samples</a>
LP2950CDT-3.0/NOPB	ACTIVE	TO-252	NDP	3	75	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LP2950 CDT-3.0	<a href="#">Samples</a>
LP2950CDT-3.3	NRND	TO-252	NDP	3	75	TBD	Call TI	Call TI	-40 to 125	LP2950 CDT-3.3	
LP2950CDT-3.3/NOPB	ACTIVE	TO-252	NDP	3	75	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LP2950 CDT-3.3	<a href="#">Samples</a>
LP2950CDT-5.0/NOPB	ACTIVE	TO-252	NDP	3	75	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LP2950 CDT-5.0	<a href="#">Samples</a>
LP2950CDTX-3.0/NOPB	ACTIVE	TO-252	NDP	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LP2950 CDT-3.0	<a href="#">Samples</a>
LP2950CDTX-3.3/NOPB	ACTIVE	TO-252	NDP	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LP2950 CDT-3.3	<a href="#">Samples</a>
LP2950CDTX-5.0	NRND	TO-252	NDP	3	2500	TBD	Call TI	Call TI	-40 to 125	LP2950 CDT-5.0	
LP2950CDTX-5.0/NOPB	ACTIVE	TO-252	NDP	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LP2950 CDT-5.0	<a href="#">Samples</a>
LP2950CZ-3.0/LFT3	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950 CZ3.0	<a href="#">Samples</a>
LP2950CZ-3.0/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	2950 CZ3.0	<a href="#">Samples</a>
LP2950CZ-3.3/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950 CZ3.3	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2950CZ-3.3/LFT3	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950 CZ3.3	<a href="#">Samples</a>
LP2950CZ-3.3/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	2950 CZ3.3	<a href="#">Samples</a>
LP2950CZ-5.0/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950 CZ5.0	<a href="#">Samples</a>
LP2950CZ-5.0/LFT3	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950 CZ5.0	<a href="#">Samples</a>
LP2950CZ-5.0/LFT7	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU	N / A for Pkg Type		2950 CZ5.0	<a href="#">Samples</a>
LP2950CZ-5.0/LFT8	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		2950 CZ5.0	<a href="#">Samples</a>
LP2950CZ-5.0/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU	N / A for Pkg Type	-40 to 125	2950 CZ5.0	<a href="#">Samples</a>
LP2951ACM	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	2951 ACM>D	
LP2951ACM-3.0/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951A CM30>D	<a href="#">Samples</a>
LP2951ACM-3.3	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	2951A CM33>D	
LP2951ACM-3.3/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951A CM33>D	<a href="#">Samples</a>
LP2951ACM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951 ACM>D	<a href="#">Samples</a>
LP2951ACMM	NRND	VSSOP	DGK	8	1000	TBD	Call TI	Call TI	-40 to 125	L0DA	
LP2951ACMM-3.0	NRND	VSSOP	DGK	8	1000	TBD	Call TI	Call TI	-40 to 125	L0BA	
LP2951ACMM-3.0/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0BA	<a href="#">Samples</a>
LP2951ACMM-3.3	NRND	VSSOP	DGK	8	1000	TBD	Call TI	Call TI	-40 to 125	L0CA	
LP2951ACMM-3.3/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0CA	<a href="#">Samples</a>
LP2951ACMM/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0DA	<a href="#">Samples</a>
LP2951ACMMX-3.0	NRND	VSSOP	DGK	8	3500	TBD	Call TI	Call TI	-40 to 125	L0BA	
LP2951ACMMX-3.0/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0BA	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2951ACMMX-3.3/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0CA	<a href="#">Samples</a>
LP2951ACMMX/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0DA	<a href="#">Samples</a>
LP2951ACMX	NRND	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	2951 ACM>D	
LP2951ACMX-3.0/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951A CM30>D	<a href="#">Samples</a>
LP2951ACMX-3.3/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951A CM33>D	<a href="#">Samples</a>
LP2951ACMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951 ACM>D	<a href="#">Samples</a>
LP2951ACN	LIFEBUY	PDIP	P	8	40	TBD	Call TI	Call TI	-40 to 125	LP 2951ACN	
LP2951ACN/NOPB	ACTIVE	PDIP	P	8	40	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP 2951ACN	<a href="#">Samples</a>
LP2951ACSD	NRND	WSO	NGT	8	1000	TBD	Call TI	Call TI	-40 to 125	2951AC	
LP2951ACSD/NOPB	ACTIVE	WSO	NGT	8	1000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	2951AC	<a href="#">Samples</a>
LP2951ACSDX-3.3/NOPB	ACTIVE	WSO	NGT	8	4500	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	51AC33	<a href="#">Samples</a>
LP2951ACSDX/NOPB	ACTIVE	WSO	NGT	8	4500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951AC	<a href="#">Samples</a>
LP2951CM	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	2951 CM>D	
LP2951CM-3.0/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951C M30>D	<a href="#">Samples</a>
LP2951CM-3.3	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	2951C M33>D	
LP2951CM-3.3/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951C M33>D	<a href="#">Samples</a>
LP2951CM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951 CM>D	<a href="#">Samples</a>
LP2951CMM	NRND	VSSOP	DGK	8	1000	TBD	Call TI	Call TI	-40 to 125	L0DB	
LP2951CMM-3.0/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0BB	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2951CMM-3.3/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0CB	<a href="#">Samples</a>
LP2951CMM/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0DB	<a href="#">Samples</a>
LP2951CMMX	NRND	VSSOP	DGK	8	3500	TBD	Call TI	Call TI	-40 to 125	L0DB	
LP2951CMMX-3.0/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0BB	<a href="#">Samples</a>
LP2951CMMX-3.3	NRND	VSSOP	DGK	8	3500	TBD	Call TI	Call TI	-40 to 125	L0CB	
LP2951CMMX-3.3/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0CB	<a href="#">Samples</a>
LP2951CMMX/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	L0DB	<a href="#">Samples</a>
LP2951CMX	NRND	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	2951 CM>D	
LP2951CMX-3.0/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951C M30>D	<a href="#">Samples</a>
LP2951CMX-3.3	NRND	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	2951C M33>D	
LP2951CMX-3.3/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951C M33>D	<a href="#">Samples</a>
LP2951CMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2951 CM>D	<a href="#">Samples</a>
LP2951CN	LIFEBUY	PDIP	P	8	40	TBD	Call TI	Call TI	-40 to 125	LP 2951CN	
LP2951CN/NOPB	ACTIVE	PDIP	P	8	40	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP 2951CN	<a href="#">Samples</a>
LP2951CSD-3.0/NOPB	ACTIVE	WSON	NGT	8	1000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	51AC30B	<a href="#">Samples</a>
LP2951CSD-3.3/NOPB	ACTIVE	WSON	NGT	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	51AC33B	<a href="#">Samples</a>
LP2951CSD/NOPB	ACTIVE	WSON	NGT	8	1000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	2951ACB	<a href="#">Samples</a>
LP2951CSDX-3.0/NOPB	ACTIVE	WSON	NGT	8	4500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	51AC30B	<a href="#">Samples</a>
LP2951CSDX-3.3/NOPB	ACTIVE	WSON	NGT	8	4500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	51AC33B	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2951CSDX/NOPB	ACTIVE	WSON	NGT	8	4500	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	2951ACB	<b>Samples</b>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2950CDTX-3.0/NOPB	TO-252	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LP2950CDTX-3.3/NOPB	TO-252	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LP2950CDTX-5.0	TO-252	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LP2950CDTX-5.0/NOPB	TO-252	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LP2951ACMM	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMM-3.0	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMM-3.0/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMM-3.3	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMM-3.3/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMM/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMMX-3.0	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMMX-3.0/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMMX-3.3/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMMX/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951ACMX	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951ACMX-3.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951ACMX-3.3/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2951ACMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951ACSD	WSON	NGT	8	1000	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LP2951ACSD/NOPB	WSON	NGT	8	1000	180.0	12.4	4.3	4.3	1.1	8.0	12.0	Q1
LP2951ACSDX-3.3/NOPB	WSON	NGT	8	4500	330.0	12.4	4.3	4.3	1.1	8.0	12.0	Q1
LP2951ACSDX/NOPB	WSON	NGT	8	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LP2951CMM	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMM-3.0/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMM-3.3/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMM/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMMX	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMMX-3.0/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMMX-3.3	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMMX-3.3/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMMX/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LP2951CMX	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951CMX-3.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951CMX-3.3	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951CMX-3.3/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951CMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LP2951CSD-3.0/NOPB	WSON	NGT	8	1000	180.0	12.4	4.3	4.3	1.1	8.0	12.0	Q1
LP2951CSD-3.3/NOPB	WSON	NGT	8	1000	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LP2951CSD/NOPB	WSON	NGT	8	1000	180.0	12.4	4.3	4.3	1.1	8.0	12.0	Q1
LP2951CSDX-3.0/NOPB	WSON	NGT	8	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LP2951CSDX-3.3/NOPB	WSON	NGT	8	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LP2951CSDX/NOPB	WSON	NGT	8	4500	330.0	12.4	4.3	4.3	1.1	8.0	12.0	Q1



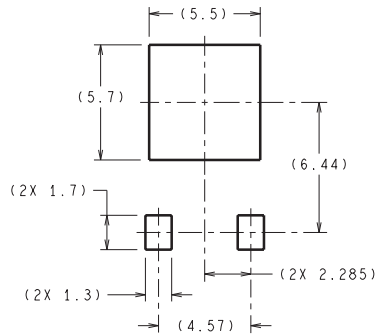
**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2950CDTX-3.0/NOPB	TO-252	NDP	3	2500	367.0	367.0	38.0
LP2950CDTX-3.3/NOPB	TO-252	NDP	3	2500	367.0	367.0	38.0
LP2950CDTX-5.0	TO-252	NDP	3	2500	367.0	367.0	35.0
LP2950CDTX-5.0/NOPB	TO-252	NDP	3	2500	367.0	367.0	38.0
LP2951ACMM	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951ACMM-3.0	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951ACMM-3.0/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951ACMM-3.3	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951ACMM-3.3/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951ACMM/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951ACMMX-3.0	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951ACMMX-3.0/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951ACMMX-3.3/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951ACMMX/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951ACMX	SOIC	D	8	2500	367.0	367.0	35.0
LP2951ACMX-3.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LP2951ACMX-3.3/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LP2951ACMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LP2951ACSD	WSO	NGT	8	1000	210.0	185.0	35.0
LP2951ACSD/NOPB	WSO	NGT	8	1000	203.0	203.0	35.0

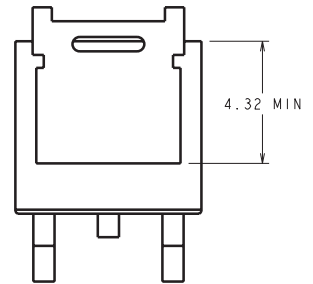
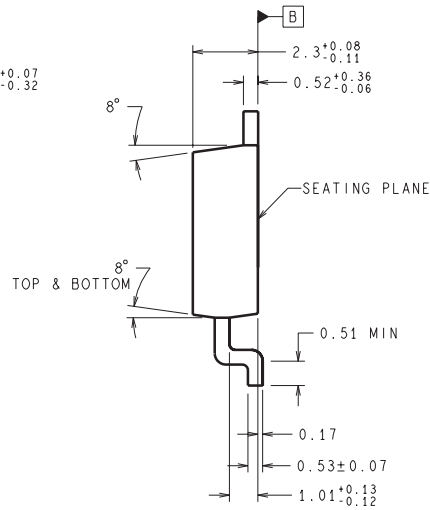
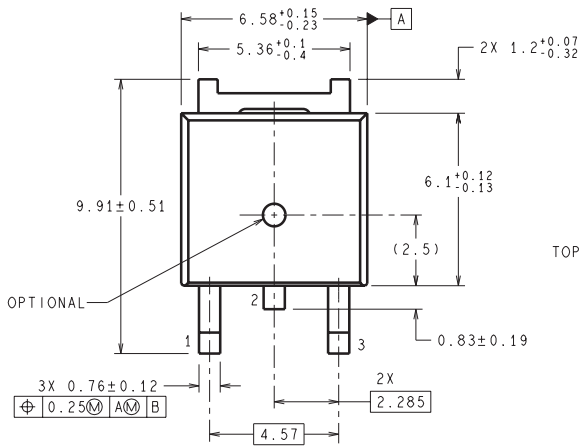
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2951ACSDX-3.3/NOPB	WSON	NGT	8	4500	346.0	346.0	35.0
LP2951ACSDX/NOPB	WSON	NGT	8	4500	367.0	367.0	35.0
LP2951CMM	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951CMM-3.0/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951CMM-3.3/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951CMM/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LP2951CMMX	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951CMMX-3.0/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951CMMX-3.3	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951CMMX-3.3/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951CMMX/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LP2951CMX	SOIC	D	8	2500	367.0	367.0	35.0
LP2951CMX-3.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LP2951CMX-3.3	SOIC	D	8	2500	367.0	367.0	35.0
LP2951CMX-3.3/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LP2951CMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LP2951CSD-3.0/NOPB	WSON	NGT	8	1000	203.0	203.0	35.0
LP2951CSD-3.3/NOPB	WSON	NGT	8	1000	210.0	185.0	35.0
LP2951CSD/NOPB	WSON	NGT	8	1000	203.0	203.0	35.0
LP2951CSDX-3.0/NOPB	WSON	NGT	8	4500	367.0	367.0	35.0
LP2951CSDX-3.3/NOPB	WSON	NGT	8	4500	367.0	367.0	35.0
LP2951CSDX/NOPB	WSON	NGT	8	4500	346.0	346.0	35.0

NDP0003B



DIMENSIONS ARE IN MILLIMETERS  
DIMENSIONS IN ( ) FOR REFERENCE ONLY

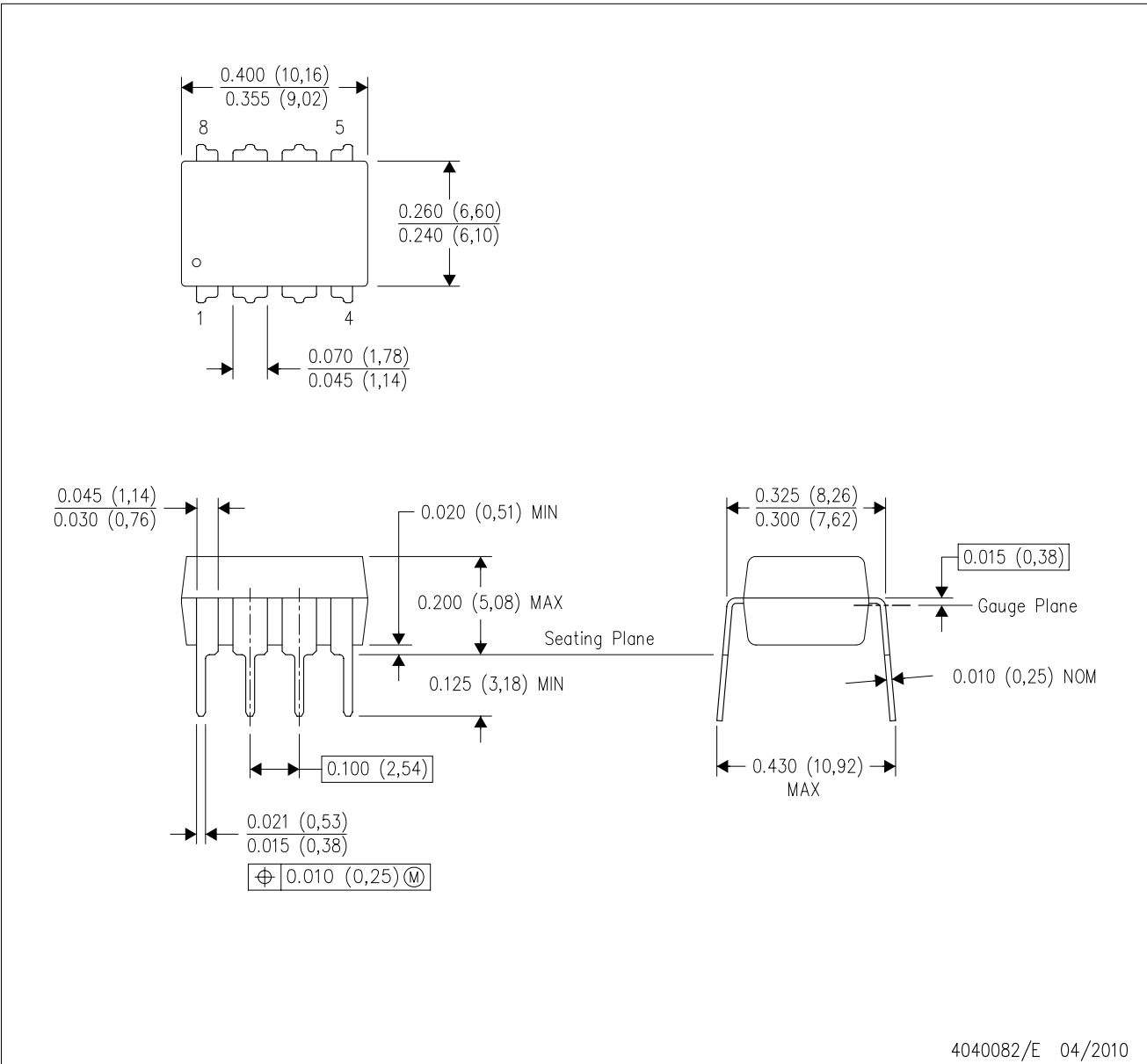
LAND PATTERN RECOMMENDATION



TD03B (Rev F)

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



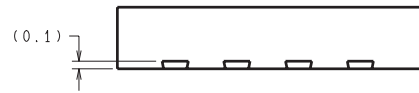
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.



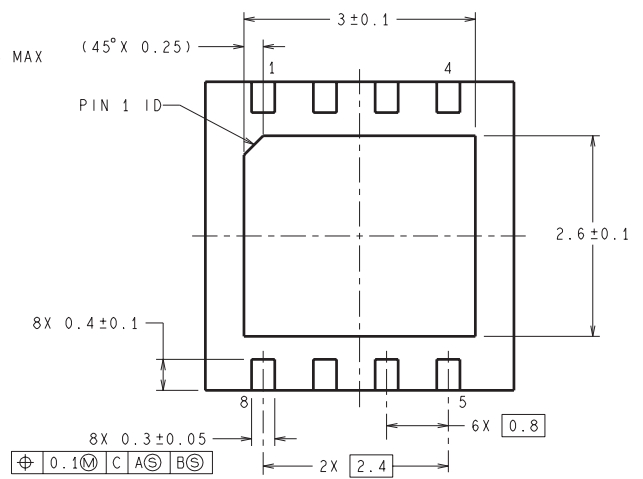
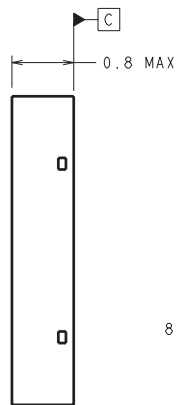
NGT0008A



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RECOMMENDED LAND PATTERN



SDC08A (Rev A)

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AA.

**MECHANICAL DATA**

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



4040001-2/E 08/13

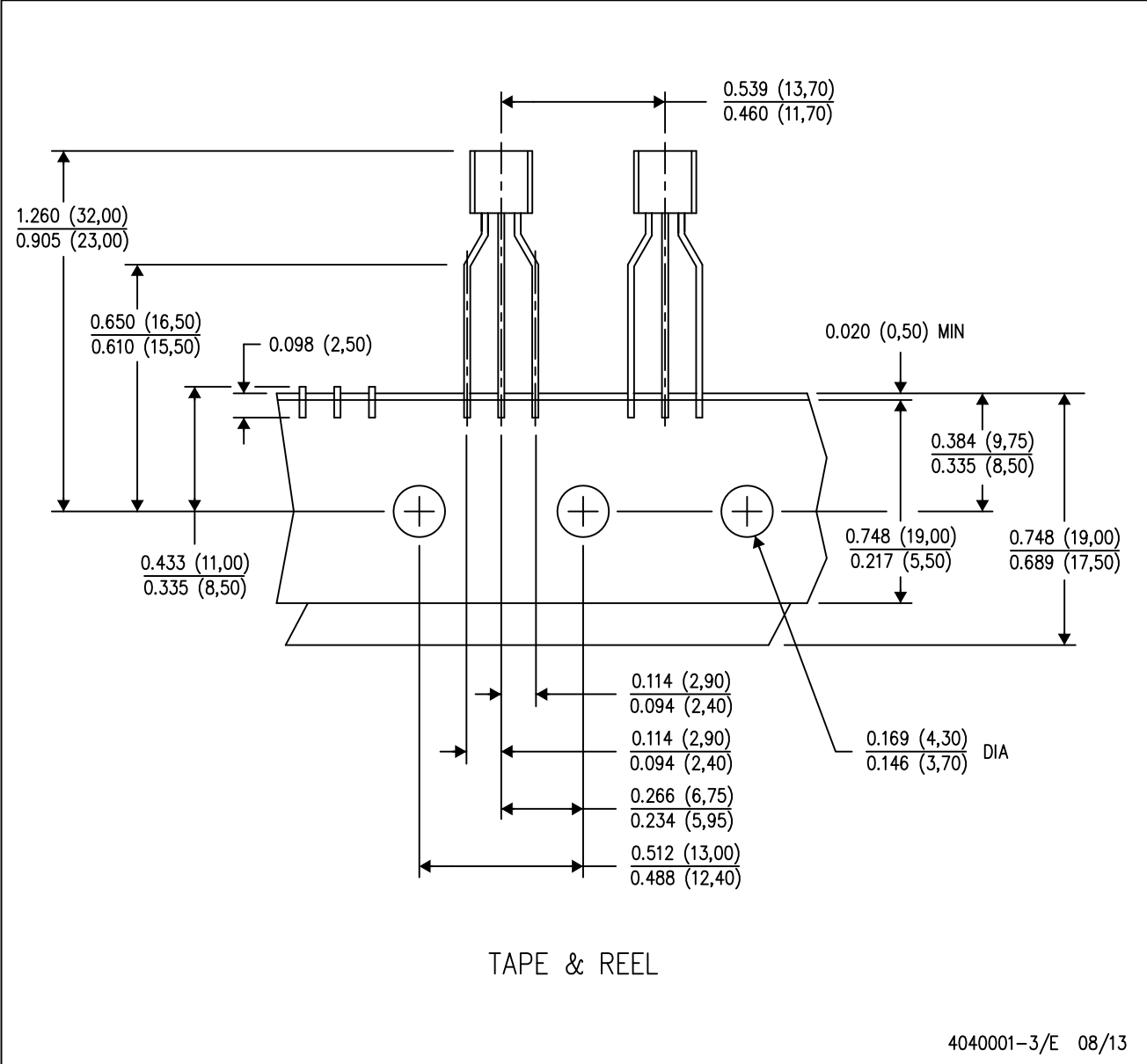
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Lead dimensions are not controlled within this area.
  - Falls within JEDEC TO-226 Variation AA (TO-226 replaces TO-92).
  - E. Shipping Method:  
 Straight lead option available in bulk pack only.  
 Formed lead option available in tape & reel or ammo pack.  
 Specific products can be offered in limited combinations of shipping mediums and lead options.  
 Consult product folder for more information on available options.



**MECHANICAL DATA**

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Tape and Reel information for the Formed Lead Option package.

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